

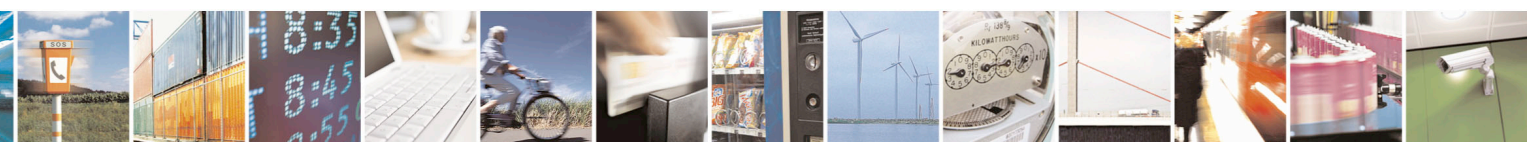
UE910-EU V2 AUTO Hardware User Guide

1VV0301072 Rev.1 – 2013-11-11



APPLICABILITY TABLE

PRODUCT
UE910-EU V2 AUTO



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1. Introduction

1.1. Scope

The aim of this document is the description of typical hardware solutions useful for developing a product with the Telit UE910-EU V2 AUTO module.

1.2. Audience

This document is intended for Telit customers who are about to implement their applications using our UE910-EU V2 AUTO modules.

1.3. Contact Information, Support

For general contact, technical support, to report documentation errors and to order manuals, contact Telit Technical Support Center (TTSC) at:

TS-EMEA@telit.com
TS-NORTHAMERICA@telit.com
TS-LATINAMERICA@telit.com
TS-APAC@telit.com

Alternatively, use:

<http://www.telit.com/en/products/technical-support-center/contact.php>

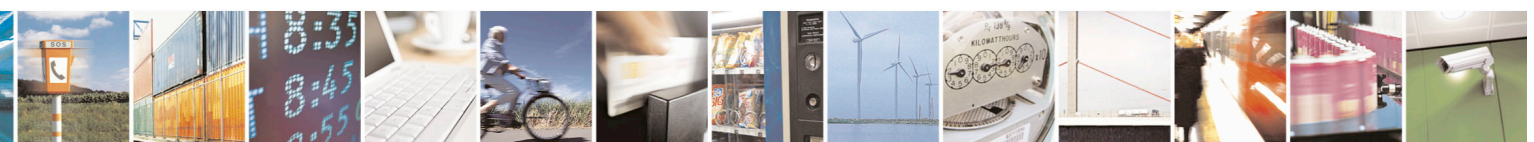
For detailed information about where to buy the Telit modules or for recommendations on accessories and components visit:

<http://www.telit.com>

To register for product news and announcements or for product questions contact Telit Technical Support Center (TTSC).

Our aim is to make this guide as helpful as possible. Please keep us informed of comments and suggestions for improvements.

Telit appreciates feedback from the users of our information.



1.4. Document Organization

This document contains the following chapters:

Chapter 1: “Introduction” provides a scope for this document, target audience, contact and support information, and text conventions.

Chapter 2: “General Product Description” gives an overview of the features of the product.

Chapter 3: “UE910-EU V2 AUTO Module Connections” deals with the pin out configuration and layout.

Chapter 4: “Hardware Commands” How to operate the module via hardware.

Chapter 5: “Power supply” Power supply requirements and general design rules.

Chapter 6: “Antenna” The antenna connection and board layout design are the most important parts in the full product design.

Chapter 7: “USB Port” The USB port on the Telit UE910-EU V2 AUTO is the core of the interface between the module and OEM hardware.

Chapter 8: “Serial ports” Refers to the serial ports of the Telit UE910-EU V2 AUTO.

Chapter 9: “Audio Section overview” Refers to the audio blocks of the Base Band Chip of the UE910-EU V2 AUTO Telit Module.

Chapter 10: “General Purpose I/O” How the general purpose I/O pads can be configured.

Chapter 11: “ADC section” Deals with this one kind of converter.

Chapter 12: “Mounting UE910-EU V2 AUTO on the Application” Mechanical dimensions and recommendations on how to mount the module on the user’s board.

Chapter 13: “Packing System” Deals with packing system.

Chapter 14: “Application Design Guide” Deals with the design of host system for download or upgrade.

Chapter 15: “Conformity Assessment Issues” provides some fundamental hints about the conformity assessment that the final application might need.

Chapter 16: “Safety Recommendation” provides some safety recommendations that must be followed by the customer in the design of the application that makes use of the Telit UE910-EU V2 AUTO.

Chapter 17: “Document History” provides document revision history of the Telit UE910-EU V2 AUTO.



1.5. Text Conventions



Danger – This information MUST be followed or catastrophic equipment failure or bodily injury may occur.



Caution or Warning – Alerts the user to important points about integrating the module. If these points are not followed, the module and end user equipment may fail or malfunction.

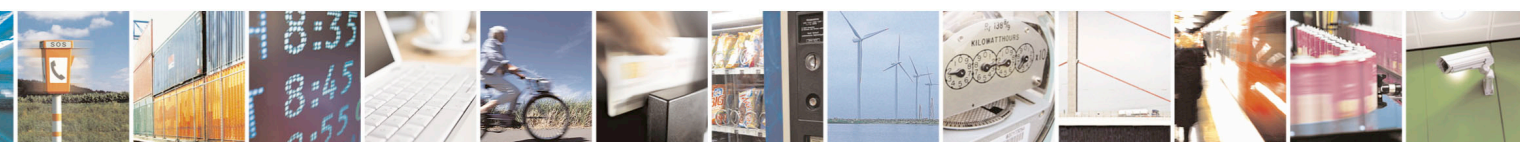


Tip or Information – Provides advice and suggestions that may be useful when integrating the module.

All dates are in ISO 8601 format, i.e. YYYY-MM-DD.

1.6. Related Documents

- UE910 V2 Software User Guide, 1VV0301066
- UE910 V2 AT Commands Reference Guide, 80419ST10124A
- Telit EVK2 User Guide, 1vw0300704



2. General Product Description

2.1. Overview

The aim of this document is the description of typical hardware solutions useful for developing a product with the Telit UE910-EU V2 AUTO module.

In this document all the basic functions of a mobile device will be taken into account; for each one of them a proper hardware solution will be suggested and eventually the wrong solutions and common errors to be avoided will be evidenced. Obviously this document cannot embrace all hardware solutions and products that may be designed. Avoiding the discussed wrong solutions must be considered as mandatory. While the suggested hardware configurations must not be considered mandatory, the information given must be used as a guide and a starting point for properly developing a product with the Telit UE910-EU V2 AUTO module.



NOTE:

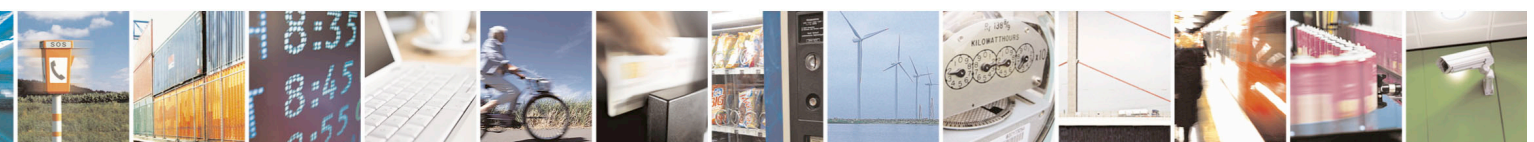
The integration of the GSM/GPRS/EGPRS/WCDMA/HSDPA UE910-EU V2 AUTO module within a user application must be done according to the design rules described in this manual.

The information presented in this document is believed to be accurate and reliable. However, no responsibility is assumed by Telit Communication S.p.A. for its use, such as any infringement of patents or other rights of third parties. No license is granted by implication or otherwise under any patent rights of Telit Communication S.p.A. other than for circuitry embodied in Telit products. This document is subject to change without notice.



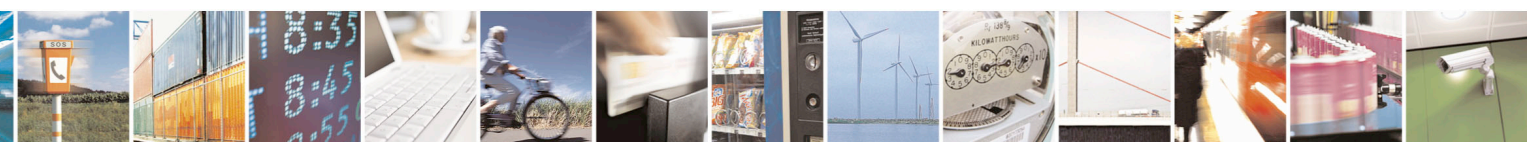
2.2. Product Specifications

ITEM	FEATUREs
Air Interface	<ul style="list-style-type: none"> Dual-Bands WCDMA/HSDPA 900/2100MHz Dual-Bands EGSM 900/DCS1800MHz
Data Service	<ul style="list-style-type: none"> HSDPA : Uplink up to 384kbps / Downlink up to 3.6Mbps(cat-6) WCDMA : Uplink/Downlink up to 384kbps EDGE : Uplink/Downlink up to 236.8kbps GPRS : Uplink/Downlink up to 85.6kbps CSD : 9.6kbps
Max. RF output power	<ul style="list-style-type: none"> GSM /GPRS <ul style="list-style-type: none"> Class4(33dBm)@900MHz Class1(30dBm)@1800MHz EDGE <ul style="list-style-type: none"> ClassE2(27dBm)@900MHz ClassE2(26dBm)@1800MHz WCDMA <ul style="list-style-type: none"> Class3(23.5dBm)@900/2100MHZ
Typical conducted sensitivity	<ul style="list-style-type: none"> GSM 900 : -108.0dBm DCS1800 : -107.0dBm WCDMA900 : -108.0dBm WCDMA2100 : -108.0dBm
Device dimensions	<ul style="list-style-type: none"> 28.2mm(L) x 28.2mm(W) x 2.2mm(T)
Weight	<ul style="list-style-type: none"> 4.1g
Storage and Operating Temperature Range	<ul style="list-style-type: none"> -40 ~ +85°C
Normal operating voltage range	<ul style="list-style-type: none"> 3.4 ~ 4.2V
IO voltage	<ul style="list-style-type: none"> 1.8V
Interface	<ul style="list-style-type: none"> 144 Land-Grid-Array interface 10 general I/O ports maximum including multi-functional I/Os State LED output 1 A/D converter Full RS232 CMOS UART: baud rate up to 4Mbps USB High speed 2.0 : baud rate up to 480Mbps
Antenna	900/1800/2100MHz
Audio	<ul style="list-style-type: none"> Analog audio interface (1 EAR/MIC) Digital Voice Interface
Message	<ul style="list-style-type: none"> SMS (MO/MT)
Approvals	R&TTE, GCF



2.3. RoHS Compliance

As a part of Telit's corporate policy of environmental protection, the UE910-EU V2 AUTO complies with the RoHS (Restriction of Hazardous Substances) directive of the European Union (EU directive 2002/95/EG).



3. UE910-EU V2 AUTO Module Connections

3.1. Pin-Out

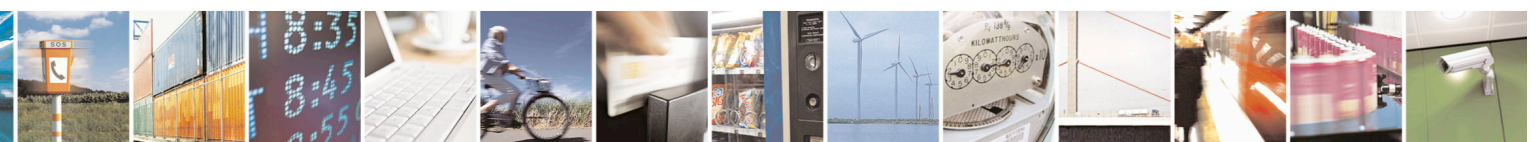
Pin	Signal	I/O	Function	Type
USB HS 2.0 Communication Port				
B15	USB_D+	I/O	USB differential Data(+)	
C15	USB_D-	I/O	USB differential Data(-)	
A13	VUSB	I	Power sense for the internal USB transceiver	5V
Asynchronous UART – Prog. / data +HW Flow Control				
N15	C103/TXD	I	Serial data input from DTE	CMOS 1.8V
M15	C104/RXD	O	Serial data output to DTE	CMOS 1.8V
M14	C108/DTR	I	Input for (DTR) from DTE	CMOS 1.8V
L14	C105/RTS	I	Input for (RTS) from DTE	CMOS 1.8V
P15	C106/CTS	O	Output for (CTS) to DTE	CMOS 1.8V
N14	C109/DCD	O	Output for (DCD) to DTE	CMOS 1.8V
P14	C107/DSR	O	Output for (DSR) to DTE	CMOS 1.8V
R14	C125/RING	O	Output for (RI) to DTE	CMOS 1.8V
SIM Interface				
A3	SIMVCC	-	External SIM signal – Power supply for the SIM	1.8/3V
A4	SIMIN	I	External SIM signal – Presence (active low)	CMOS 1.8V
A5	SIMIO	I/O	External SIM signal – Data I/O	1.8/3V
A6	SIMCLK	O	External SIM signal – Clock	1.8/3V
A7	SIMRST	O	External SIM signal – Reset	1.8/3V
Digital Voice interface				
B9	DVI_WA0	I/O	Digital Voice Interface	CMOS 1.8V
B6	DVI_RX	I/O	Digital Voice Interface	CMOS 1.8V
B7	DVI_TX	I/O	Digital Voice Interface	CMOS 1.8V
B8	DVI_CLK	I/O	Digital Voice Interface	CMOS 1.8V
Analog Voice Interface				
B2	EAR+	AO	Earphone signal output, phase +	
B3	EAR-	AO	Earphone signal output, phase -	
B4	MIC+	AI	Microphone input, phase +	
B5	MIC-	AI	Microphone input, phase -	
Digital IO				
C8	GPIO_01	I/O	GPIO_01 / STAT LED	CMOS 1.8V
C9	GPIO_02	I/O	GPIO_02	CMOS 1.8V
C10	GPIO_03	I/O	GPIO_03	CMOS 1.8V
C11	GPIO_04	I/O	GPIO_04	CMOS 1.8V
B14	GPIO_05	I/O	GPIO_05	CMOS 1.8V
C12	GPIO_06	I/O	GPIO_06	CMOS 1.8V
C13	GPIO_07	I/O	GPIO_07	CMOS 1.8V
K15	GPIO_08	I/O	GPIO_08	CMOS 1.8V
L15	GPIO_09	I/O	GPIO_09	CMOS 1.8V



Pin	Signal	I/O	Function	Type
G15	GPIO_10	I/O	GPIO_10	CMOS 1.8V
ADC Section				
B1	ADC_IN1	AI	Analog to Digital converter input	A/D
RF Section				
K1	Antenna	I/O	GSM/WCDMA Antenna (50Ohm)	RF
Miscellaneous Functions				
R13	HW_SHUTDOWN*	I	Hardware Unconditional Shutdown	Pull up to VBATT
R12	ON_OFF*	I	Input Command for Power ON	CMOS 1.8V
C14	VRTC	I	RTC Power	Power
R11	VAUX/PWRMON	O	Supply Output for external accessories / Power ON Monitor	1.8V
Power Supply				
M1	VBATT	-	Main Power Supply (Baseband)	Power
M2	VBATT	-	Main Power Supply (Baseband)	Power
N1	VBATT_PA	-	Main Power Supply (Radio PA)	Power
N2	VBATT_PA	-	Main Power Supply (Radio PA)	Power
P1	VBATT_PA	-	Main Power Supply (Radio PA)	Power
P2	VBATT_PA	-	Main Power Supply (Radio PA)	Power
E1	GND	-	Ground	
G1	GND	-	Ground	
H1	GND	-	Ground	
J1	GND	-	Ground	
L1	GND	-	Ground	
A2	GND	-	Ground	
E2	GND	-	Ground	
F2	GND	-	Ground	
G2	GND	-	Ground	
H2	GND	-	Ground	
J2	GND	-	Ground	
K2	GND	-	Ground	
L2	GND	-	Ground	
R2	GND	-	Ground	
M3	GND	-	Ground	
N3	GND	-	Ground	
P3	GND	-	Ground	
R3	GND	-	Ground	
D4	GND	-	Ground	
M4	GND	-	Ground	
N4	GND	-	Ground	
P4	GND	-	Ground	
R4	GND	-	Ground	
N5	GND	-	Ground	
P5	GND	-	Ground	
R5	GND	-	Ground	
N6	GND	-	Ground	
P6	GND	-	Ground	



Pin	Signal	I/O	Function	Type
R6	GND	-	Ground	
P8	GND	-	Ground	
R8	GND		Ground	
P9	GND	-	Ground	
P10	GND	-	Ground	
R10	GND	-	Ground	
M12	GND	-	Ground	
B13	GND	-	Ground	
P13	GND	-	Ground	
E14	GND	-	Ground	
Reserved				
C1	Reserved	-	Reserved	
D1	Reserved	-	Reserved	
F1	Reserved	-	Reserved	
C2	Reserved	-	Reserved	
D2	Reserved	-	Reserved	
C3	Reserved	-	Reserved	
D3	Reserved	-	Reserved	
E3	Reserved	-	Reserved	
F3	Reserved	-	Reserved	
G3	Reserved	-	Reserved	
H3	Reserved	-	Reserved	
J3	Reserved	-	Reserved	
K3	Reserved	-	Reserved	
L3	Reserved	-	Reserved	
C4	Reserved	-	Reserved	
C5	Reserved	-	Reserved	
C6	Reserved	-	Reserved	
C7	Reserved	-	Reserved	
N7	Reserved	-	Reserved	
P7	Reserved	-	Reserved	
R7	Reserved	-	Reserved	
A8	Reserved	-	Reserved	
N8	Reserved	-	Reserved	
A9	Reserved	-	Reserved	
N9	Reserved	-	Reserved	
R9	Reserved	-	Reserved	
A10	Reserved	-	Reserved	
B10	Reserved	-	Reserved	
N10	Reserved	-	Reserved	
A11	Reserved	-	Reserved	
B11	Reserved	-	Reserved	
N11	Reserved	-	Reserved	
P11	Reserved	-	Reserved	
A12	Reserved	-	Reserved	
B12	Reserved	-	Reserved	

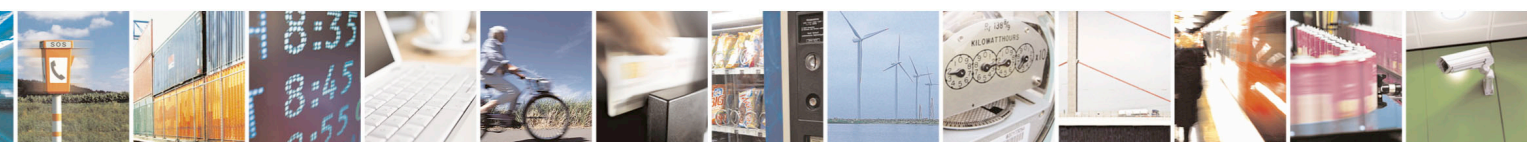


Pin	Signal	I/O	Function	Type
D12	Reserved	-	Reserved	
N12	Reserved	-	Reserved	
P12	Reserved	-	Reserved	
D13	Reserved	-	Reserved	
E13	Reserved	-	Reserved	
F13	Reserved	-	Reserved	
G13	Reserved	-	Reserved	
H13	Reserved	-	Reserved	
J13	Reserved	-	Reserved	
K13	Reserved	-	Reserved	
L13	Reserved	-	Reserved	
M13	Reserved	-	Reserved	
N13	Reserved	-	Reserved	
A14	Reserved	-	Reserved	
D14	Reserved	-	Reserved	
F14	Reserved	-	Reserved	
G14	Reserved	-	Reserved	
H14	Reserved	-	Reserved	
J14	Reserved	-	Reserved	
K14	Reserved	-	Reserved	
D15	Reserved	-	Reserved	
E15	Reserved	-	Reserved	
F15	Reserved	-	Reserved	
H15	Reserved	-	Reserved	
J15	Reserved	-	Reserved	



WARNING:

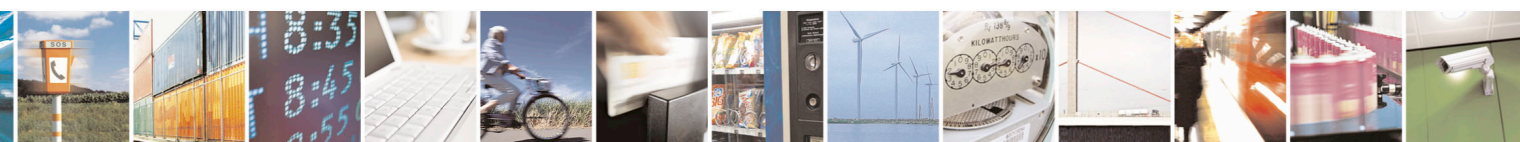
Reserved pins must not be connected.





If not used, almost all pins not in use must be left disconnected. The only exceptions are the following pins:

PAD	Signal	Notes
M1,M2,N1,N2,P1,P2	VBATT&VBATT_PA	
E1,G1,H1,J1,L1,A2,E2,F2,G2,H2,J2,K2,L2,R2,M3,N3,P3,R3,D4,M4,N4,P4,R4,N5,P5,R5,N6,P6,R6,P8,R8,P9,P10,R10,M12,B13,P13,E14	GND	
R12	ON/OFF*	
R13	HW_SHUTDOWN*	
B15	USB_D+	If not used it should be connected to a Test point.
C15	USB_D-	If not used it should be connected to a Test point.
A13	VUSB	If not used it should be connected to a Test point.
N15	C103/TXD	If not used it should be connected to a Test point.
M15	C104/RXD	If not used it should be connected to a Test point.
L14	C105/RTS	If the flow control is not used it should be connected to GND.
P15	C106/CTS	If not used it should be connected to a Test point.
K1	Main Antenna	



	A	B	C	D	E	F	G	H	J	K	L	M	N	P	R
1		ADC_IN1	RES	RES	GND	RES	GND	GND	GND	ANTENNA	GND	VBATT	VBATT_PA	VBATT_PA	
2	GND	EAR+	RES	RES	GND	GND	GND	GND	GND	GND	GND	VBATT	VBATT_PA	VBATT_PA	GND
3	SIMVCC	EAR-	RES	RES	RES	RES	RES	RES	RES	RES	RES	GND	GND	GND	GND
4	SIMIN	MIC+	RES	GND								GND	GND	GND	GND
5	SIMIO	MIC-	RES										GND	GND	GND
6	SIMCLK	DVI_RX	RES										GND	GND	GND
7	SIMRST	DVI_TX	RES										RES	RES	RES
8	RES	DVI_CLK	GPIO_01 / STAT_LED										RES	GND	GND
9	RES	DVI_WA0	GPIO_02										RES	GND	RES
10	RES	RES	GPIO_03										RES	GND	GND
11	RES	RES	GPIO_04										RES	RES	VAUX/PWRM ON
12	RES	RES	GPIO_06	RES								GND	RES	RES	ON_OFF*
13	VUSB	GND	GPIO_07	RES	RES	RES	RES	RES	RES	RES	RES	RES	RES	GND	HW_SHUTD OWN*
14	RES	GPIO_05	VRTC	RES	GND	RES	RES	RES	RES	RES	C105/RTS	C108/DTR	C109/DCD	C107/DSR	C125/RING
15		USB_D+	USB_D-	RES	RES	RES	GPIO_10	RES	RES	GPIO_08	GPIO_09	C104/RXD	C103/TXD	C106/CTS	

Top View



The pin defined as **RES** must be considered RESERVED and not connected on any pin in the application. The related area on the application has to be kept empty.

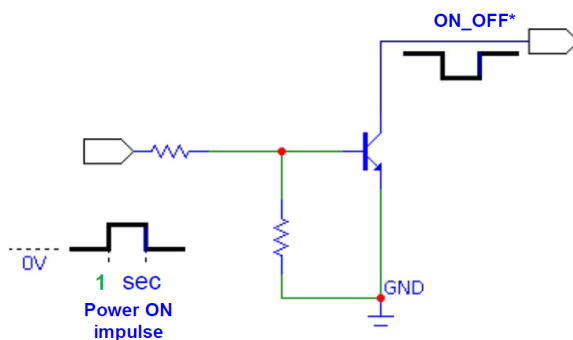


4. Hardware Commands

4.1. Turning on the UE910-EU V2 AUTO module

To turn on the UE910-EU V2 AUTO, the pad ON_OFF* must be tied low for at least 1 second and then released. The maximum current that can be drained from the ON_OFF* pad is 0.1 mA.

A simple circuit to power on the module is illustrated below:

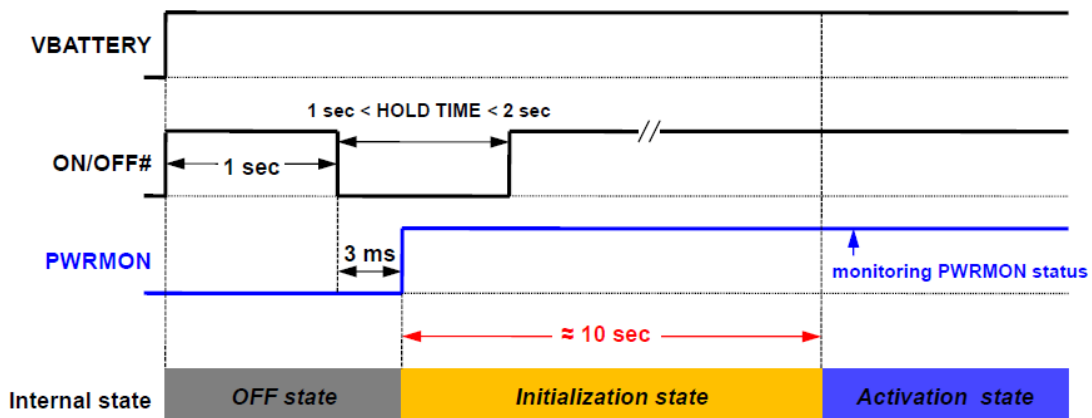


4.1.1. Initialization and Activation State

Upon turning on UE910-EU V2 AUTO module, the UE910-EU V2 AUTO module is not active yet because the boot sequence of UE910-EU V2 AUTO is still executing internally. It takes about 10 seconds to complete the initialization of the module internally.

For this reason, it would be useless to try to access UE910-EU V2 AUTO during the Initialization state as below. The UE910-EU V2 AUTO module needs at least 10 seconds after the PWRMON goes High to become operational by reaching the activation state.





During the *Initialization state*, any kind of AT-command is not available. DTE must wait for the *Activation state* to communicate with UE910-EU V2 AUTO.

To check if the UE910-EU V2 AUTO has powered on, the hardware line VAUX/PWRMON must be monitored. When VAUX/PWRMON goes high, the module has powered on.



NOTE:

Do not use any pull up resistor on the ON_OFF* line. It is pulled up with 250kΩ internally. Using a pull up resistor may bring latch up problems on the UE910-EU V2 AUTO power regulator and improper power on/off of the module. The line ON_OFF* must be connected only in open collector configuration.



NOTE:

In this document all the lines are inverted. Active low signals are labeled with a name that ends with "*" or with a bar over the name.



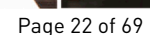
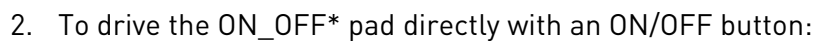
NOTE:

In order to avoid a back powering effect it is recommended to avoid having any HIGH logic level signal applied to the digital pins of the UE910-EU V2 AUTO module when the module is powered OFF or during an ON/OFF transition.

For example:

1. To drive the ON_OFF* pad with a totem pole output of a +3/5 V microcontroller (uP_OUT1):





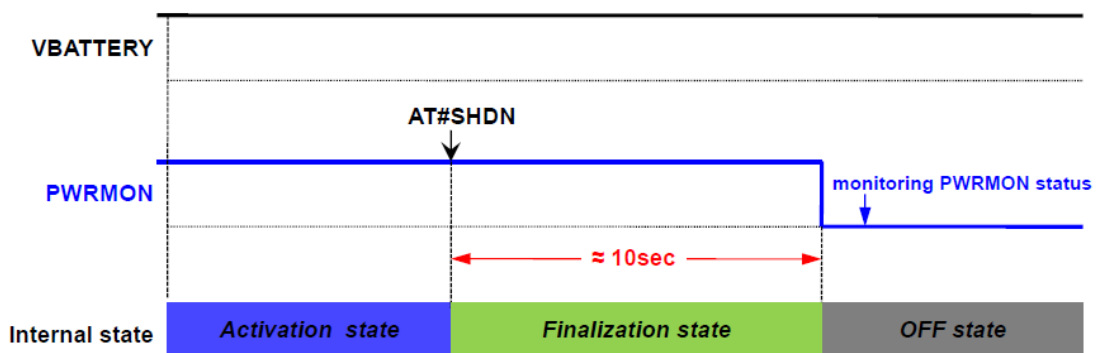
In order to avoid a back powering effect it is recommended to avoid having any HIGH logic level signal applied to the digital pins of the UE910-EU V2 AUTO when the module is powered OFF or during an ON/OFF transition.

4.2.1. Turning OFF by AT Command

The UE910-EU V2 AUTO can be shut down by a software command.

When a shutdown command is sent, the UE910-EU V2 AUTO goes into the finalization state and will shut down PWRMON at the end of this state. The period of the finalization state can vary according to the state of the UE910-EU V2 AUTO so it cannot be fixed definitely.

Normally it will be 10 seconds after sending a shutdown command and DTE should monitor the status of PWRMON to see the actual power off.



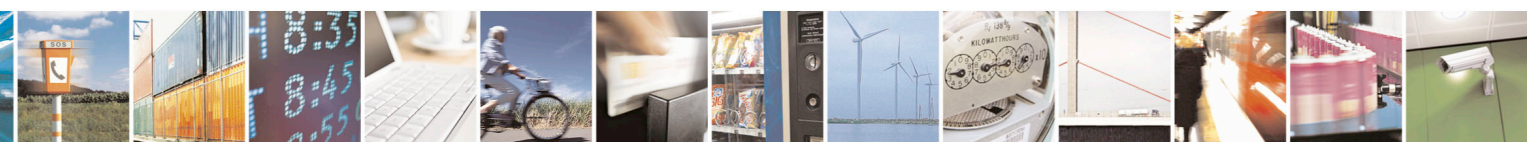
4.2.2. Turning OFF by tying low ON_OFF*

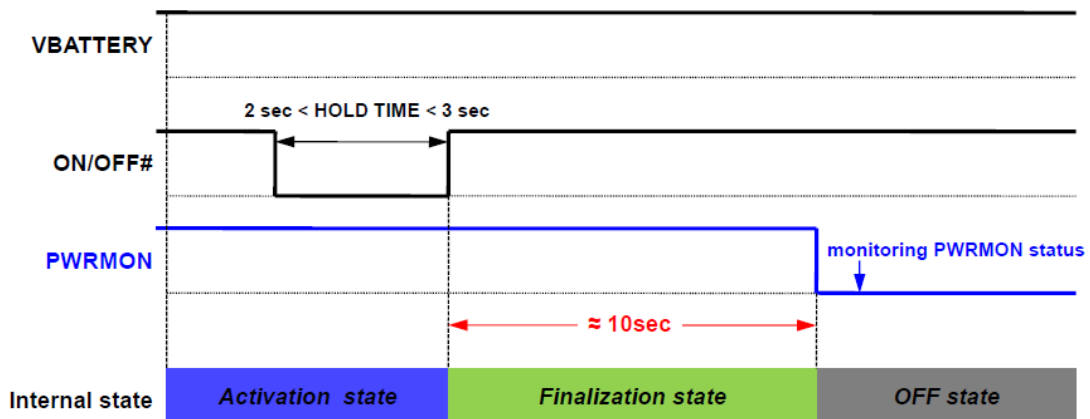
To turn OFF the UE910-EU V2 AUTO the pad ON_OFF* must be tied low for at least 2 seconds and then released. The same circuitry and timing for the power on must be used.

When the hold time of ON_OFF* is above 2 seconds, the UE910-EU V2 AUTO goes into the finalization state and will shut down PWRMON at the end of this state.

The period of the finalization state can vary according to the state of the UE910-EU V2 AUTO so it cannot be fixed definitely.

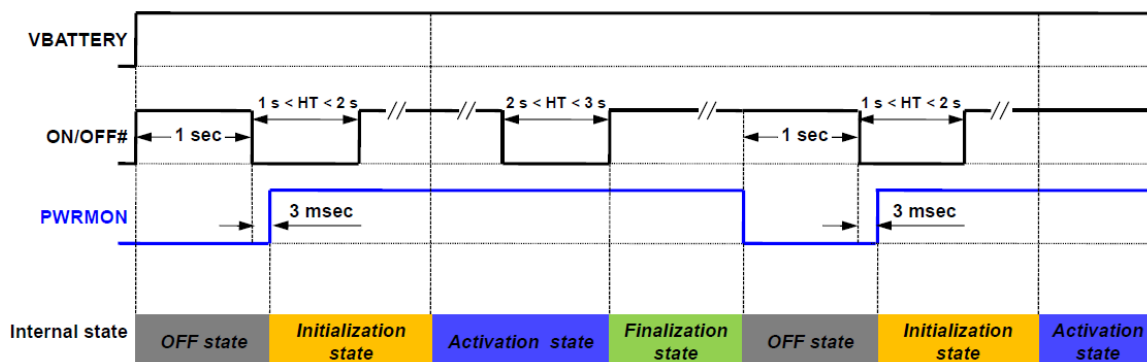
Normally it will be 10 seconds after releasing ON_OFF* and DTE should monitor the status of PWRMON to see the actual power off.





4.3. Summary of Turning ON and OFF the Module

The chart below describes the overall sequences for turning ON and OFF the module.



4.4. Hardware Unconditional Shutdown

The Unconditional shutdown of the module could be activated using the HW_SHUTDOWN* line(pad R13).



WARNING:

The hardware unconditional shutdown must NOT be used during normal operation of the device since it does not detach the device from the network. It shall be used as an emergency exit procedure.



To unconditionally shutdown the UE910-EU V2 AUTO, the pad HW_SHUTDOWN* must be tied low for at least 0.8 seconds and then released.



NOTE:

Do not use any pull up resistor on the HW_SHUTDOWN* line nor any totem pole digital output. It is pulled up internally to VBATT with 57kΩ. Using an external pull up resistor may bring latch up problems on the UE910-EU V2 AUTO power regulator and improper functioning of the module.

The line HW_SHUTDOWN* must be connected only in open collector configuration.

The HW_SHUTDOWN* will generate an unconditional shutdown of the module without an automatic restart.

The module will shutdown but will NOT perform the detach from the cellular network.

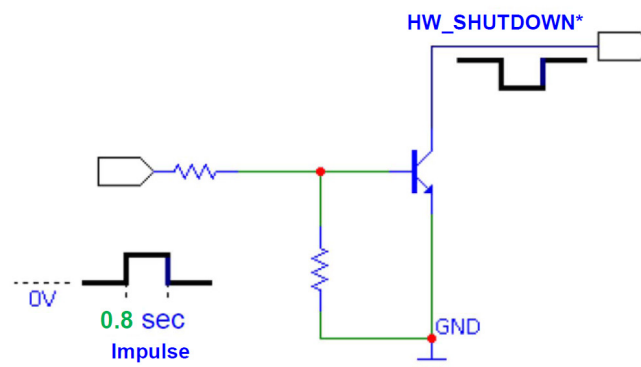
To proper power on again the module please refer to 4.1 Turning ON the UE910-EU V2 AUTO.



TIP:

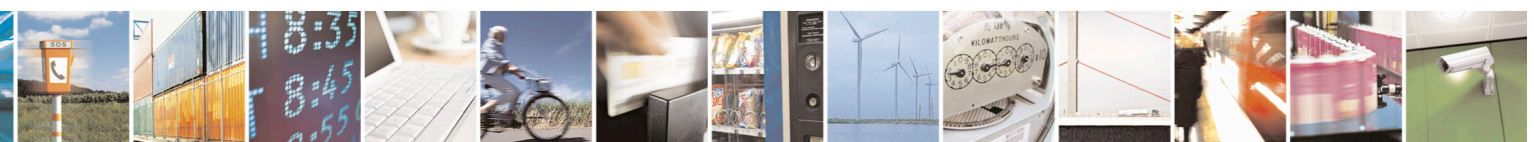
The unconditional hardware shutdown must always be implemented on the boards and the software must use it only as an emergency exit procedure.

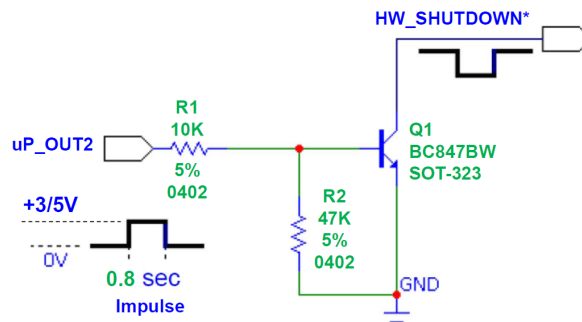
A simple circuit to unconditionally shutdown the module is illustrated below:



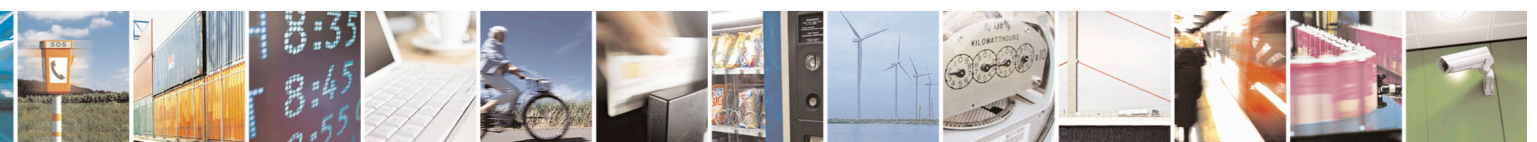
For example:

Let us assume you need to drive the HW_SHUTDOWN* pad with a totem pole output of a +3/5 V microcontroller (uP_OUT2):





NOTE: In order to avoid a back powering effect it is recommended to avoid having any HIGH logic level signal applied to the digital pins of the UE910-EU V2 AUTO when the module is powered OFF or during an ON/OFF transition.



5. Power Supply

The power supply circuitry and board layout are a very important part in the full product design and they strongly reflect on the product's overall performance. Read carefully the requirements and the guidelines that follow for a proper design.

5.1. Power Supply Requirements

The external power supply must be connected to VBATT & VBATT_PA signals and must fulfill the following requirements:

Power Supply	
Nominal Supply Voltage	3.8V
Normal Operating Voltage range	3.4V ~ 4.2V
Extended Operating Voltage range	3.4V ~ 4.5V



NOTE:

The Operating Voltage Range MUST never be exceeded. Special care must be taken when designing the application's power supply section to avoid having an excessive voltage drop.

If the voltage drop is exceeding the limits it could cause a Power Off of the module..

Behavior in the extended operating voltage range might deviate from 3GPP specification.



5.2. Power Supply Requirements

Current Consumption		
Mode	Average (mA)	Mode Description
Power off current (Typical)		< 10uA
Standby mode		No call in progress
AT+CFUN=1	22	Normal mode; full functionality of the module
AT+CFUN=4	20	Disabled TX and RX; modules is not registered on the network
AT+CFUN=0 or AT+CFUN=5	4.8/1.2*	Power saving; CFUN=0 module registered on the network and can receive voice call or an SMS; but it is not possible to send AT commands; module wakes up with an unsolicited code (call or SMS) or rising RTS line. CFUN=5 full functionality with power saving; Module registered on the network can receive incoming call sand SMS
Tx and Rx mode		A call in progress
Max Power Mode	700	WCDMA/HSDPA voice/data call
Max Power Mode	700	EU : GPRS Class12
	440	NA : GPRS Class10
Max Power Mode	420	EU : EGPRS Class12
	270	NA : EGPRS Class10

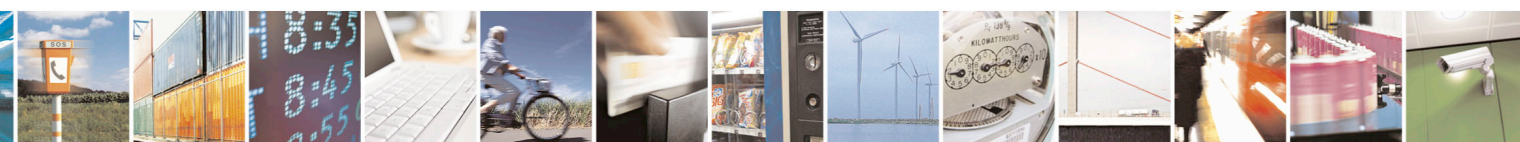
*Worst/best case depends on network configuration and is not under module control.



TIP:

The electrical design for the power supply should be made ensuring it will be capable of a peak current output of at least 2A.

In GSM/GPRS mode, RF transmission is not continuous and it is packed into bursts at a base frequency of about 216 Hz, and the relative current peaks can be as high as about 2A. Therefore the power supply has to be designed in order to withstand these current peaks without big voltage drops; this means that both the electrical design and the board layout must be designed for this current flow. If the layout of the PCB is not well designed, a strong noise floor is generated on the ground; this will reflect on all the audio paths producing an audible annoying noise at 216 Hz; if the voltage drops during the peak, current absorption is too much. The device may even shut down as a consequence of the supply voltage drop.



5.3. General Design Rules

The principal guidelines for the Power Supply Design embrace three different design steps:

- the electrical design
- the thermal design
- the PCB layout

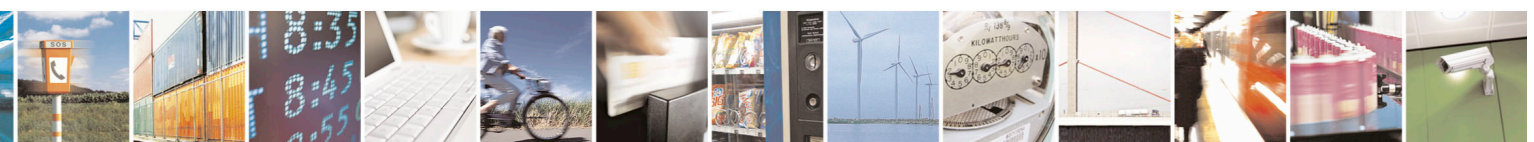
5.3.1. Electrical Design Guidelines

The electrical design of the power supply depends strongly on the power source where this power is drained. We will distinguish them into three categories:

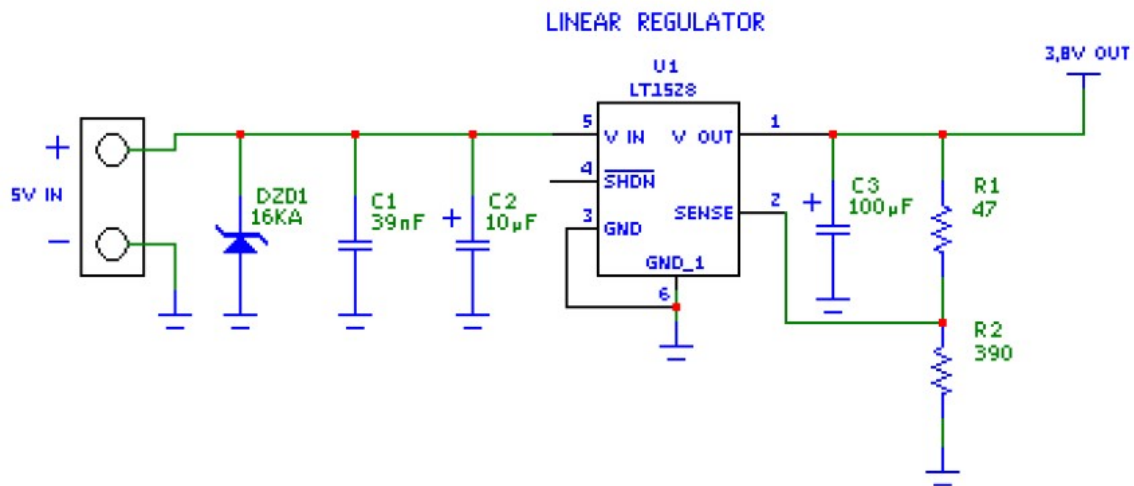
- +5V input (typically PC internal regulator output)
- +12V input (typically automotive)
- Battery

5.3.2. + 5V Input Source Power Supply Design Guidelines

- The desired output for the power supply is 3.8V, hence there is not a big difference between the input source and the desired output so a linear regulator can be used. A switching power supply will not be suitable because of the low drop-out requirements.
- When using a linear regulator, a proper heat sink must be provided in order to dissipate the power generated.
- A Bypass low ESR capacitor of adequate capacity must be provided in order to cut the current absorption peaks close to the UE910-EU V2 AUTO. A tantalum 100 μ F capacitor is usually suited.
- Make sure the low ESR capacitor on the power supply output (usually a tantalum one) is rated at least 10V.
- A protection diode must be inserted close to the power input in order to save the UE910-EU V2 AUTO from power polarity inversion.

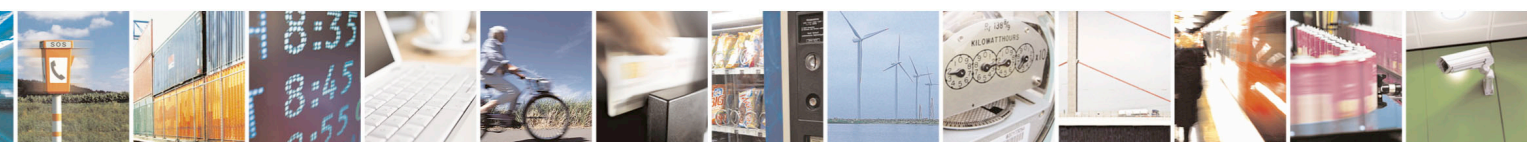


An example of a linear regulator with 5V input:



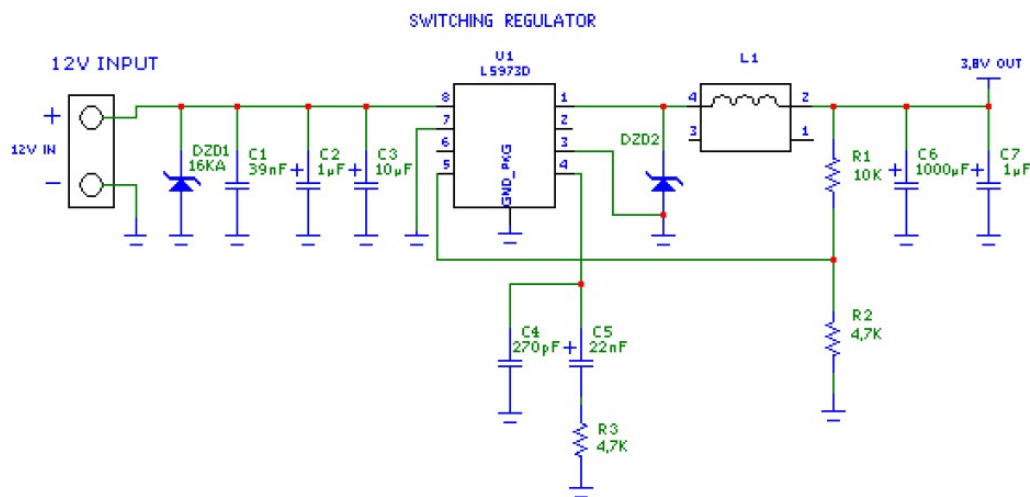
5.3.3. +12V Input Source Power Supply Design Guidelines

- The desired output for the power supply is 3.8V, hence due to the big difference between the input source and the desired output, a linear regulator is not suitable and must not be used. A switching power supply would be preferable because of its better efficiency, especially with the 2A peak current load represented by UE910-EU V2 AUTO.
- When using a switching regulator, a 500 kHz or more switching frequency regulator is preferable because of its smaller inductor size and its faster transient response. This allows the regulator to respond quickly to the current peaks absorption.
- In any case, the frequency and switching design selection is related to the application to be developed due to the fact the switching frequency could also generate EMC interferences.
- For car PB battery the input voltage can rise up to 15.8V and this must be kept in mind when choosing components: all components in the power supply must withstand this voltage.
- A bypass low ESR capacitor of adequate capacity must be provided in order to cut the current absorption peaks. A 100µF tantalum capacitor is usually suited for this.
- Make sure the low ESR capacitor on the power supply output (usually a tantalum one) is rated at least 10V.



- For car applications a spike protection diode must be inserted close to the power input in order to clean the supply from spikes.
- A protection diode must be inserted close to the power input in order to save the UE910-EU V2 AUTO from power polarity inversion. This can be the same diode as for spike protection.

An example of switching regulator with 12V input is in the schematic below:



5.3.4. Battery Source Power Supply Design Guidelines

The desired nominal output for the power supply is 3.8V and the maximum voltage allowed is 4.2V. A single 3.7V lithium-ion cell battery type is ideal to supply power to the Telit UE910-EU V2 AUTO module.



WARNING:

The three battery cells (Ni/Cd or Ni/MH 3.6V nom. battery types or 4V PB types) MUST NOT be used directly because their maximum voltage can rise over the absolute maximum voltage for the UE910-EU V2 AUTO and cause damage. USE only Li-Ion battery types.

- A bypass low (usually a 100uF tantalum) ESR capacitor with adequate capacity must be provided in order to cut the current absorption peaks.
- Make sure the low ESR capacitor (usually a tantalum) is rated at least 10V.
- A protection diode must be inserted close to the power input in order to protect the UE910-EU V2 AUTO module from power polarity inversions when connecting the battery.
- The battery capacity must be at least 500mAh in order to withstand the current peaks of 2A. The suggested battery capacity is from 500mAh to 1000mAh.



5.3.5. Thermal Design Guidelines

The thermal design for the power supply heat sink must be done with the following specifications:

Average current consumption during GSM/WCDMA @PWR level max : 700mA



NOTE:

The average consumption during transmissions depends on the power level at which the device is requested to transmit via the network. The average current consumption hence varies significantly.

Considering the very low current during idle, especially if the Power Saving function is enabled, it is possible to consider from the thermal point of view that the device absorbs current significantly only during calls.

If we assume that the device stays in transmission for short periods of time (a few minutes) and then remains for quite a long time in idle (one hour), then the power supply always has time to cool down between the calls and the heat sink could be smaller than the calculated for 700mA maximum RMS current. There could even be a simple chip package (no heat sink).

Moreover in average network conditions the device is requested to transmit at a lower power level than the maximum and hence the current consumption will be less than 700mA (usually around 200 mA).

For these reasons the thermal design is rarely a concern and the simple ground plane where the power supply chip is placed can be enough to ensure a good thermal condition and avoid overheating.

The heat generated by the UE910-EU V2 AUTO must be taken into consideration during transmission at 23.5dBm max during calls. This generated heat will be mostly conducted to the ground plane under the UE910-EU V2 AUTO. The application must be able to dissipate heat.

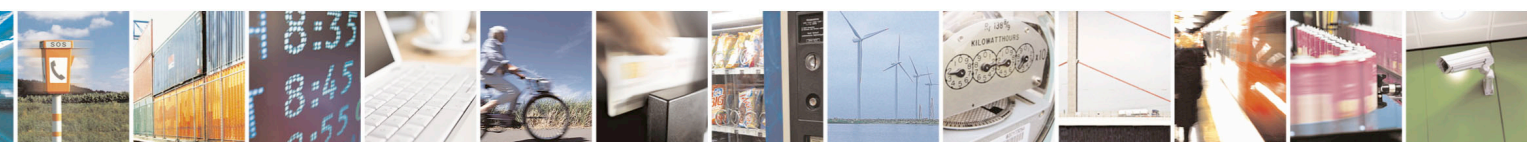
In the GSM/WCDMA mode, since UE910-EU V2 AUTO emits RF signals continuously during transmission, special attention must be paid to how to dissipate the heat generated.

The current consumption will be up to about 700mA in GSM/WCDMA continuously at the maximum TX output power. Thus, you must arrange the area on the application PCB must be as large as possible under UE910-EU V2 AUTO.

The UE910-EU V2 AUTO must be mounted on the large ground area of the application board and make many ground vias to dissipate the heat.

5.3.6. Power Supply PCB layout Guidelines

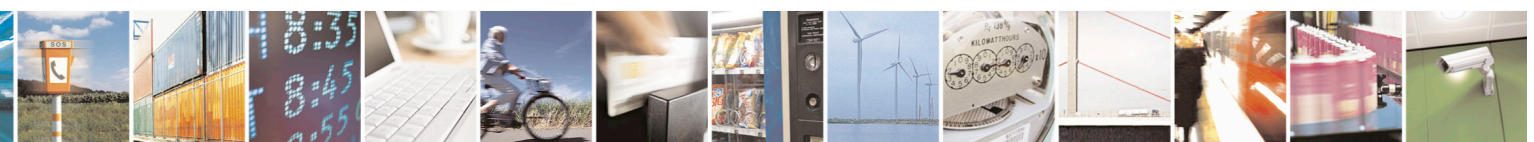
As seen in the electrical design guidelines, the power supply must have a low ESR capacitor on the output to cut the current peaks and a protection diode on the input to protect the supply from spikes and polarity inversion. The placement of these components is crucial for



the correct operation of the circuitry. A misplaced component can be useless or can even decrease the power supply performance.

- The bypass low ESR capacitor must be placed close to the Telit UE910-EU V2 AUTO power input pads, or if the power supply is a switching type, the capacitor can be placed close to the inductor to cut the ripple if the PCB trace from the capacitor to UE910-EU V2 AUTO is wide enough to ensure a drop-less connection even during the 2A current peaks.
- The protection diode must be placed close to the input connector where the power source is drained.
- The PCB traces from the input connector to the power regulator IC must be wide enough to ensure no voltage drops occur when the 2A current peaks are absorbed. While a voltage drop of hundreds of mV may be acceptable from the power loss point of view, the same voltage drop may not be acceptable from the noise point of view. If the application does not have an audio interface but only uses the data feature of the Telit UE910-EU V2 AUTO, then this noise is not as disruptive and the power supply layout design can be more forgiving.
- The PCB traces to UE910-EU V2 AUTO and the Bypass capacitor must be wide enough to ensure no significant voltage drops occur when the 2A current peaks are absorbed. This is a must for the same above-mentioned reasons. Try to keep this trace as short as possible.
- The PCB traces connecting the switching output to the inductor and the switching diode must be kept as short as possible by placing the inductor and the diode very close to the power switching IC (only for switching power supply). This is done in order to reduce the radiated field (noise) at the switching frequency (usually 100-500 kHz).
- The use of a good common ground plane is suggested.
- The placement of the power supply on the board must be done in a way to guarantee that the high current return paths in the ground plane are not overlapped with any noise sensitive circuitry such as the microphone amplifier/buffer or earphone amplifier.

The power supply input cables must be kept separate from noise sensitive lines such as microphone/earphone cables.



6. Antenna

The antenna connection and board layout design are the most important parts in the full product design and they strongly reflect on the product's overall performance. Read carefully and follow the requirements and the guidelines for a proper design.

6.1. GSM/WCDMA Antenna Requirements

The antenna for a Telit UE910-EU V2 AUTO device must fulfill the following requirements:

GSM / WCDMA Antenna Requirements	
Frequency range	Depending on the frequency band(s) provided by the network operator, the customer must use the most suitable antenna for that/those band(s)
Bandwidth	EGSM900 : 80 MHz GSM1800(DCS) : 170 MHz WCDMA FDD-I(2100) : 250 MHz WCDMA FDD-VIII(900) : 80 MHz
Gain	Gain < 2dBi
Impedance	50 Ohm
Input power	> 33dBm(2 W) peak power in GSM > 23.5dBm Average power in WCDMA
VSWR absolute max	<= 5:1(limit to avoid permanent damage)
VSWR recommended	<= 2:1(limit to fulfill all regulatory requirements)

When using the Telit UE910-EU V2 AUTO, since there's no antenna connector on the module, the antenna must be connected to the UE910-EU V2 AUTO antenna pad (K1) by means of a transmission line implemented in the PCB.

In the case that the antenna is not directly connected at the antenna pad of the UE910-EU V2 AUTO, then a PCB line is required. This transmission line shall fulfill the following requirements:

Antenna Line on PCB Requirements	
Characteristic Impedance	50Ohm
Max Attenuation	0.3dB
Coupling with other signals shall be avoided	



Cold End (Ground Plane) of antenna shall be equipotential to the UE910-EU V2 AUTO ground pads

Furthermore if the device is developed for the US and/or Canada market, it must comply with the FCC and/or IC approval requirements:

This device is to be used only for mobile and fixed application. The antenna(s) used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter. End-Users must be provided with transmitter operation conditions for satisfying RF exposure compliance. OEM integrators must ensure that the end user has no manual instructions to remove or install the UE910-EU V2 AUTO module. Antennas used for this OEM module must not exceed 2dBi gain for mobile and fixed operating configurations.

6.2. GSM/WCDMA antenna – PCB line Guidelines

- Make sure that the transmission line's characteristic impedance is 50ohm.
- Keep line on the PCB as short as possible since the antenna line loss shall be less than around 0.3dB.
- Line geometry should have uniform characteristics, constant cross section, avoid meanders and abrupt curves.
- Any kind of suitable geometry/structure can be used for implementing the printed transmission line afferent the antenna.
- If a Ground plane is required in line geometry, that plane has to be continuous and sufficiently extended so the geometry can be as similar as possible to the related canonical model.
- Keep, if possible, at least one layer of the PCB used only for the Ground plane; If possible, use this layer as reference Ground plane for the transmission line.
- It is wise to surround (on both sides) the PCB transmission line with Ground. Avoid having other signal tracks facing directly the antenna line track.
- Avoid crossing any un-shielded transmission line footprint with other tracks on different layers.
- The Ground surrounding the antenna line on PCB has to be strictly connected to the main Ground plane by means of via holes (once per 2mm at least) placed close to the ground edges facing line track.
- Place EM noisy devices as far as possible from UE910-EU V2 AUTO antenna line.
- Keep the antenna line far away from the UE910-EU V2 AUTO power supply lines.
- If EM noisy devices are present on the PCB hosting the UE910-EU V2 AUTO, such as fast switching ICs, take care of shielding them with a metal frame cover.
- If EM noisy devices are not present around the line use of geometries like Micro strip or Grounded Coplanar Waveguide are preferred since they typically ensure less attenuation when compared to a Strip line having same length.

6.3. GSM/WCDMA Antenna installation Guidelines

- Install the antenna in a place covered by the GSM/WCDMA signal.
- If the device antenna in the application is located greater then 20cm from the human body and



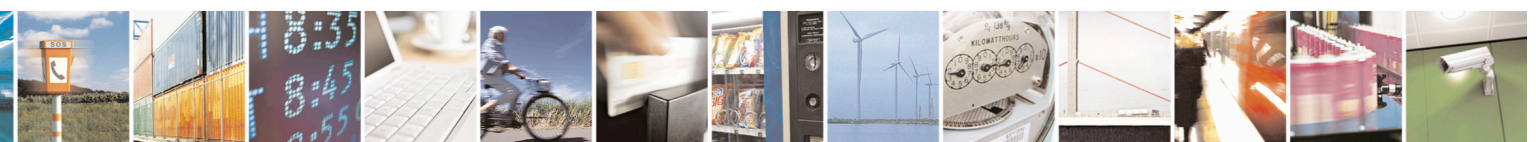
there are no co-located transmitters then the Telit FCC/IC approvals can be re-used by the end product.

- Antenna shall not be installed inside metal cases.
- Antenna shall be installed also according to antenna manufacture instructions.



WARNING:

Consider a mechanical design and a low-capacitance ESD protection device to protect UE910-EU V2 AUTO or customer specific requirements from ESD event to Antenna port (K1).



7. USB Port

The UE910-EU V2 AUTO module includes a Universal Serial Bus (USB) transceiver, which operates at USB High-speed (480Mbps/sec) and slave mode only.

It is compliant with the USB 2.0 specification and can be used for diagnostic monitoring, control and data transfers.

The table below describes the USB interface signals:

Pin	Signal	I/O	Function	Type
B15	USB D+	I/O	USB differential Data(+)	
C15	USB D-	I/O	USB differential Data(+)	
A13	VUSB	I	Power sense for the internal USB transceiver	5V

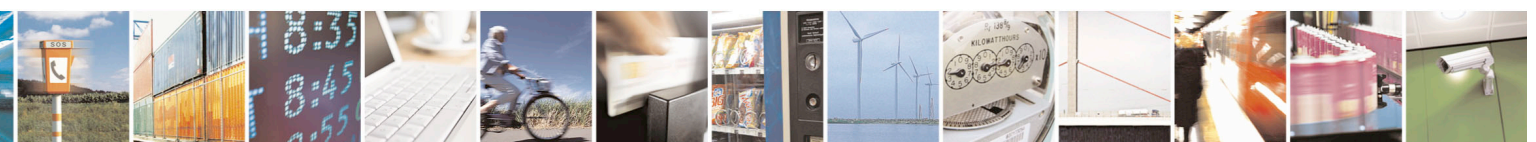
The table below describes the VUSB specification:

Parameter	Min	Typ	Max
Input voltage	4.75V	5.0V	5.25V



WARNING:

Consider a mechanical design and a low-capacitance ESD protection device to protect UE910-EU V2 AUTO or customer specific requirements from ESD event to USB lines (B15, C15 and A13).



8. Serial Port

The serial port on the Telit UE910-EU V2 AUTO is the interface between the module and OEM hardware.

Only one serial port is available on the module:

- Modem Serial Port 1 (Main)

Several configurations can be designed for the serial port on the OEM hardware.

The most common are:

- RS232 PC comport
- Microcontroller UART@1.8V(Universal Asynchronous Receiver Transmit)
- Microcontroller UART@5V or other voltages different from 1.8V

Depending on the type of serial port on the OEM hardware, a level translator circuit may be needed to make the system work.

On the UE910-EU V2 AUTO the ports are CMOS 1.8V.

The electrical characteristics of the serial port are explained in the following tables:

Absolute Maximum Ratings -Not Functional

Parameter	Min	Max
Input level on non-power pin with respect to ground	-0.3	+2.3V

Operating Range - Interface levels (1.8V CMOS)

Parameter	Min	Max
Input high level	1.5V	2.1 V
Input low level	0V	0.35V
Output high level	1.35V	1.8V
Output low level	0V	0.45V



According to V.24, RX/TX signal names are referred to the application side. Therefore, on the UE910-EU V2 AUTO side these signals are on the opposite direction:

TXD on the application side will be connected to the receive line (here named C103/TXD)

RXD in the application side will be connected to the transmit line (here named C104/RXD)

**NOTE:**

For minimum implementation, only the TXD and RXD lines must be connected, the other lines can be left open provided a software flow control is implemented.

**NOTE:**

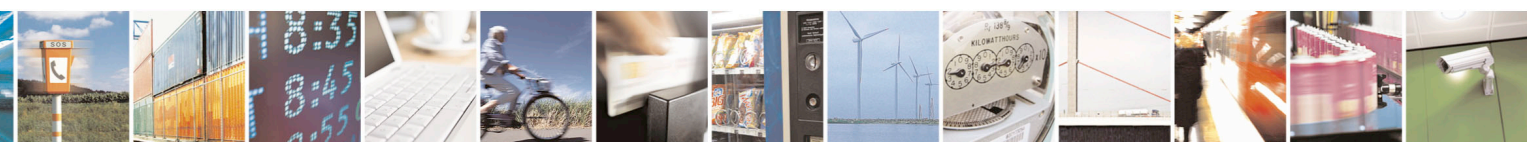
In order to avoid a back powering effect it is recommended to avoid having any HIGH logic level signal applied to the digital pins of the UE910-EU V2 AUTO when the module is powered off or during an ON/OFF transition.

**NOTE:**

High-speed UART supports up to 4Mbps. Please refer to the AT command User Guide in detail.

**WARNING:**

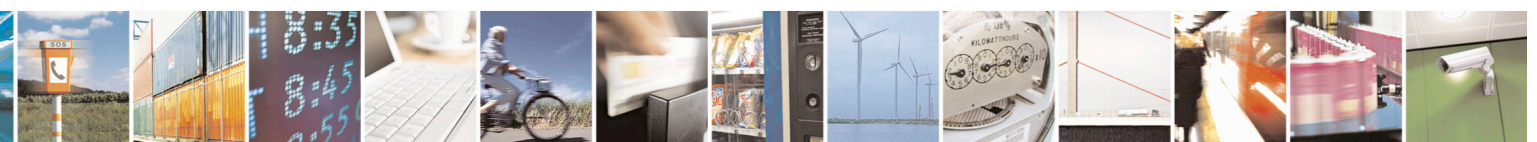
Consider a mechanical design and a low-capacitance ESD protection device to protect UE910-EU V2 AUTO or customer specific requirements from ESD event to UART port (M15, N15, P15 and L14).



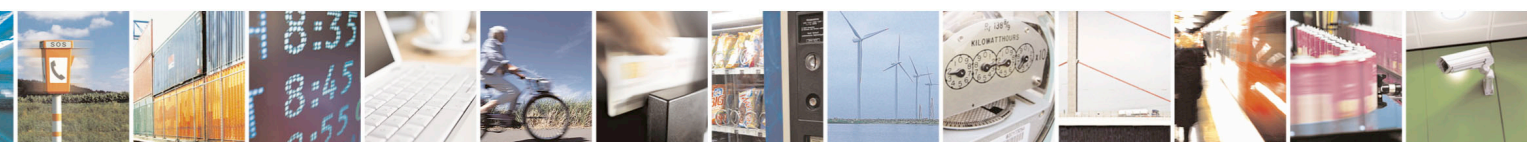
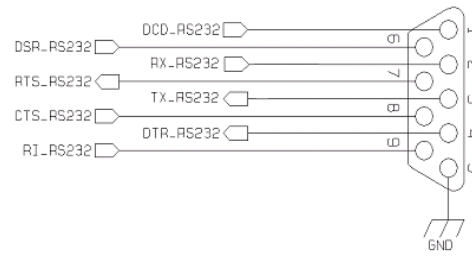
8.2. Modem Serial Port 2

The secondary serial port on the UE910-EU V2 AUTO is not supported.

PAD	Signal	I/O	Function	Type
D15	Reserved	-	Reserved	
E15	Reserved	-	Reserved	



RS232 Level Translation



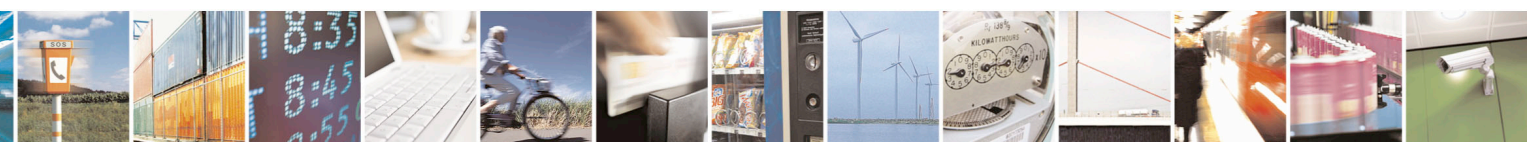
9. Audio Section Overview

The UE910-EU V2 AUTO provides an analog audio interface and digital audio interface.

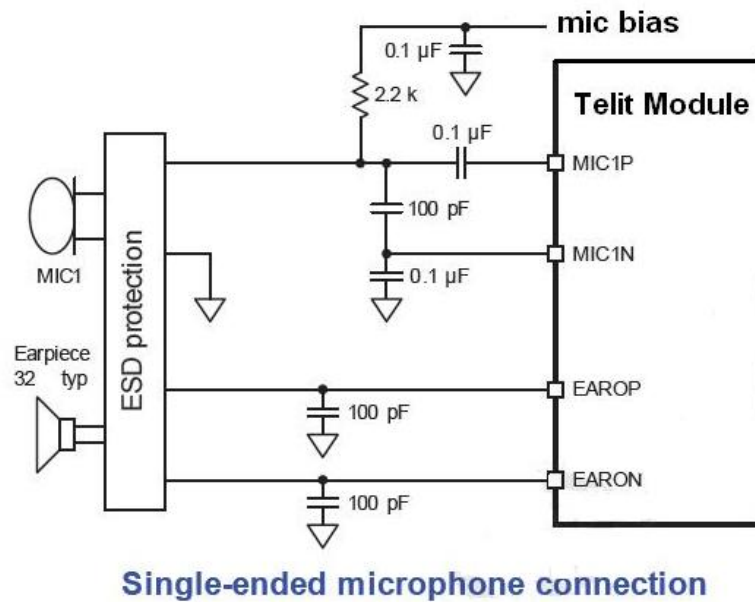
9.1. Analog Audio Interface

The UE910-EU V2 AUTO provides an analog audio interface; one differential input for audio to be transmitted(Uplink) and a balanced output for audio to be received(Downlink).

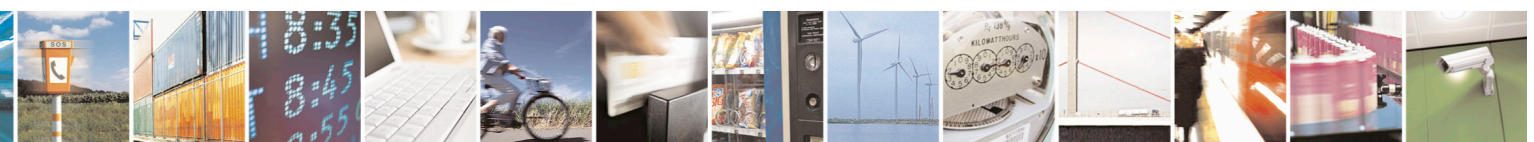
The bias for the microphone has to be as clean as possible; the first connection (single ended) is preferable since the Vmic noise and ground noise are fed into the input as common mode and then rejected. This sounds strange; usually the connection to use in order to reject the common mode is the balanced one. In this situation we have to recall that the microphone is a sound to current transducer, so the resistor is the current to tension transducer, so finally the resistor feeds the input in balanced way even if the configuration, from a microphone point of view, seems to be un-balanced.

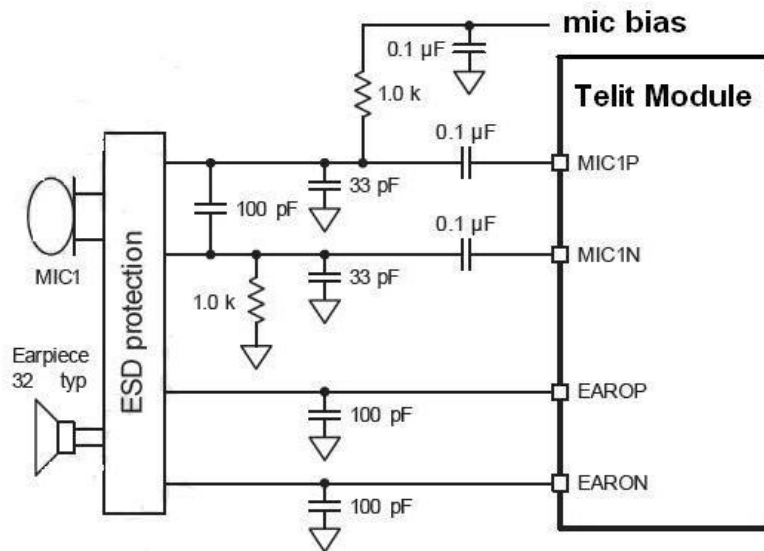


9.1.1. MIC Connection



If a “balanced way” is anyway desired, much more care has to be taken to VMIC noise and ground noise.

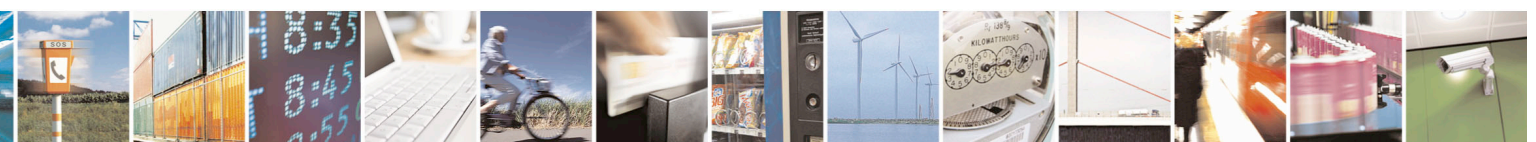




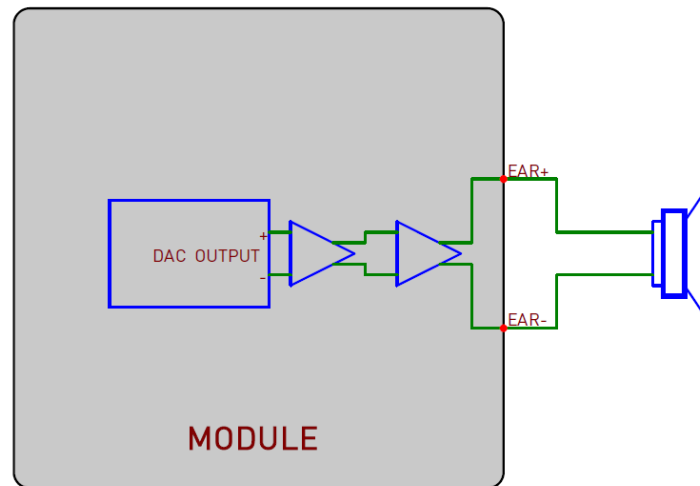
Differential microphone connection



TIP: Since the J-FET transistor inside the microphone acts as RF-detector-amplifier, ask vendor for a microphone with anti-EMI capacitor (usually a 33pF or a 10pF capacitor placed across the output terminals inside the case).



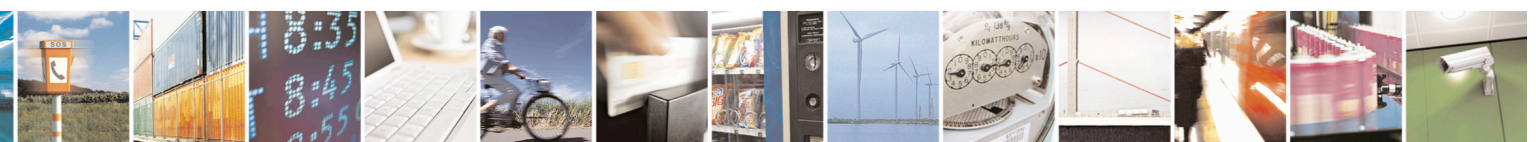
9.1.3. EAR Connection



The audio output of the UE910-EU V2 AUTO is balanced, this is helpful to double the level and to reject common mode (click and pop are common mode and therefore rejected). These outputs can drive directly a small loudspeaker with electrical impedance not lower than 32Ohm.



TIP: in order to get the maximum audio level at a given output voltage level (dBspl/Vrms), the following breaking through procedure can be used. Have the loudspeaker as close as you can to the listener (this simplify also the echo cancelling); choose the loudspeaker with the higher sensitivity (dBspl per W); choose loudspeakers with the impedance close to the limit in order to feed more power inside the transducer (it increases the W/Vrms ratio). If this were not enough, an external amplifier should be used.



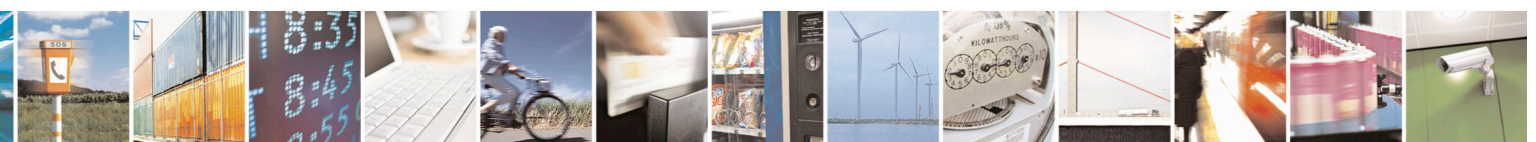
9.2. Digital Voice Interface(DVI)

The product is providing one Digital Audio Interface (DVI) on the following Pins:

Pin	Signal	I/O	Function	Type
B9	DVI_WA0	I/O	Digital Voice interface (WA0)	1.8V
B6	DVI_RX	I	Digital Voice interface (RX)	
B7	DVI_TX	O	Digital Voice interface (TX)	
B8	DVI_CLK	I/O	Digital Voice interface (CLK)	

9.2.1. CODEC Example

Please refer to the Digital Voice Interface Application note.



10. General Purpose I/O

The UE910-EU V2 AUTO module is provided by a set of Digital Input / Output pins

Input pads can only be read; they report the digital value (high or low) present on the pad at the read time.

Output pads can only be written or queried and set the value of the pad output.

An alternate function pad is internally controlled by the UE910-EU V2 AUTO firmware and acts depending on the function implemented.

The following GPIOs are available on the UE910-EU V2 AUTO:

Pin	Signal	I/O	Function	Type	Default State	Note
C8	GPIO_01	I/O	Configurable GPIO	CMOS 1.8V	INPUT	Alternate function STAT_LED
C9	GPIO_02	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
C10	GPIO_03	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
C11	GPIO_04	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
B14	GPIO_05	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
C12	GPIO_06	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
C13	GPIO_07	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
K15	GPIO_08	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
L15	GPIO_09	I/O	Configurable GPIO	CMOS 1.8V	INPUT	
G15	GPIO_10	I/O	Configurable GPIO	CMOS 1.8V	INPUT	



10.1. Logic Level Specification

Where not specifically stated, all the interface circuits work at 1.8V CMOS logic levels.

The following table shows the logic level specifications used in the UE910-EU V2 AUTO interface circuits:

Absolute Maximum Ratings -Not Functional

Parameter	Min	Max
Input level on any digital pin (CMOS 1.8) with respect to ground	-0.3V	2.3V

Operating Range - Interface levels (1.8V CMOS)

Parameter	Min	Max
Input high level	1.5V	2.1V
Input low level	0.0V	0.35V
Output high level	1.35V	1.8V
Output low level	0.0V	0.45V

Current characteristics

Parameter	Typical
Output Current	2mA
Input Current	30uA

10.2. Using a GPIO Pad as Input

The GPIO pads, when used as inputs, can be connected to a digital output of another device and report its status, provided this device has interface levels compatible with the 1.8V CMOS levels of the GPIO.

If the digital output of the device to be connected with the GPIO input pad has interface levels different from the 1.8V CMOS, then it can be buffered with an open collector transistor with a 47K ~~Output~~ resistor to 1.8V.



NOTE:

In order to avoid a back powering effect it is recommended to avoid having any HIGH logic level signal applied to the digital pins of the module when it is powered OFF or during an ON/OFF transition.



10.3. Using a GPIO Pad as Output

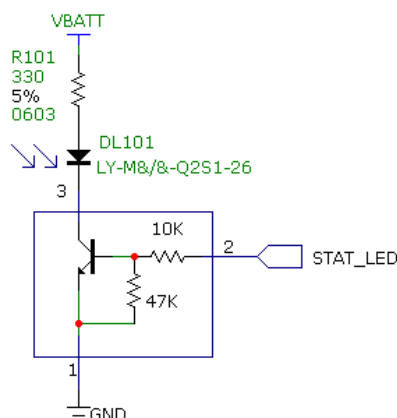
The GPIO pads, when used as outputs, can drive 1.8V CMOS digital devices or compatible hardware. When set as outputs, the pads have a push-pull output and therefore the pull-up resistor may be omitted.

10.4. Indication of Network Service Availability

The STAT_LED pin status shows information on the network service availability and Call status. In the UE910-EU V2 AUTO modules, the STAT_LED usually needs an external transistor to drive an external LED. Because of the above, the status indicated in the following table is reversed with respect to the pin status:

LED status	Device Status
Permanently off	Device off
Fast blinking (Period 1s, Ton 0,5s)	Net search / Not registered / turning off
Slow blinking (Period 3s, Ton 0,3s)	Registered full service
Permanently on	a call is active

A schematic example could be:



10.5. RTC Bypass Output

The VRTC pin brings out the Real Time Clock supply, which is separate from the rest of the digital part, allowing having only RTC going on when all the other parts of the device are off.

To this power output a backup capacitor can be added in order to increase the RTC autonomy during power off of the battery. NO Devices must be powered from this pin.

In order to keep the RTC active when VBATT is not supplied it is possible to back up the RTC section connecting a backup circuit to the related VRTC signal (pad C14 on module's Pinout).

For additional details on the Backup solutions please refer to the related application note (xE910 RTC Backup Application Note)

10.6. VAUX/PWRMON Power Output

A regulated power supply output is provided in order to supply small devices from the module. This output is active when the module is ON and goes OFF when the module is shut down. The operating range characteristics of the supply are:

Operating Range – VAUX/PWRMON power supply

Parameter	Min	Typical	Max
Output voltage	1.77V	1.8V	1.83V
Output current			200mA
Output bypass capacitor (Inside the module)		2.2 μ F	



11. ADC section

11.1. Description

The on board ADC is 12-bit converter. It is able to read a voltage level in the range of 0 ~ 1.2 volts applied on the ADC pin input and store and convert it into 12 bit word.

Parameter	Min	Max	Units
Input Voltage range	0	1.2	Volt
AD conversion	-	12	bits
Resolution	-	< 1	mV
Input Resistance	1		Mohm

The UE910-EU V2 AUTO provides one Analog to Digital Converter.

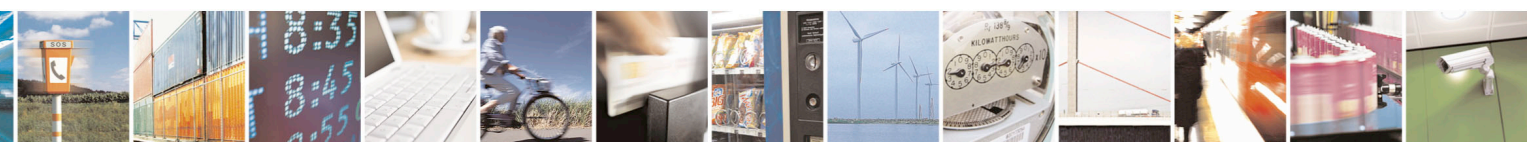
The input line is named as ADC_IN1 and it is available on pad B1.

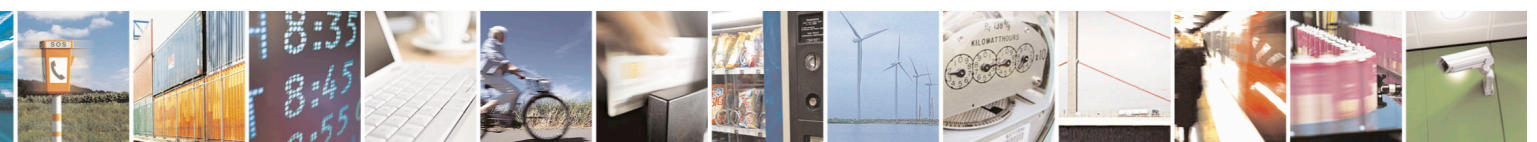
11.2. Using ADC Converter

An AT command is available to use the ADC function.

The command is AT#ADC=1,2. The read value is expressed in mV

Refer to SW User Guide or AT Commands Reference Guide for the full description of this function.





12. Mounting UE910-EU V2 AUTO on the Application

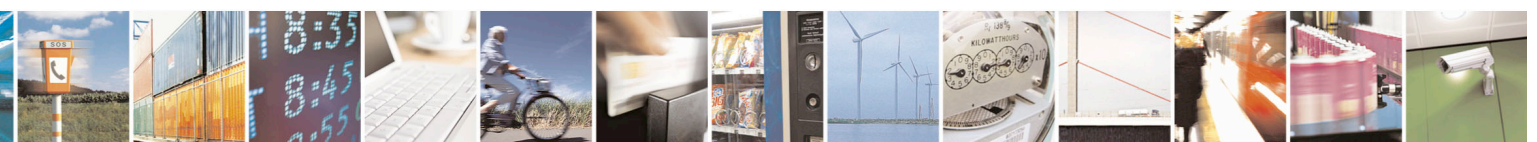
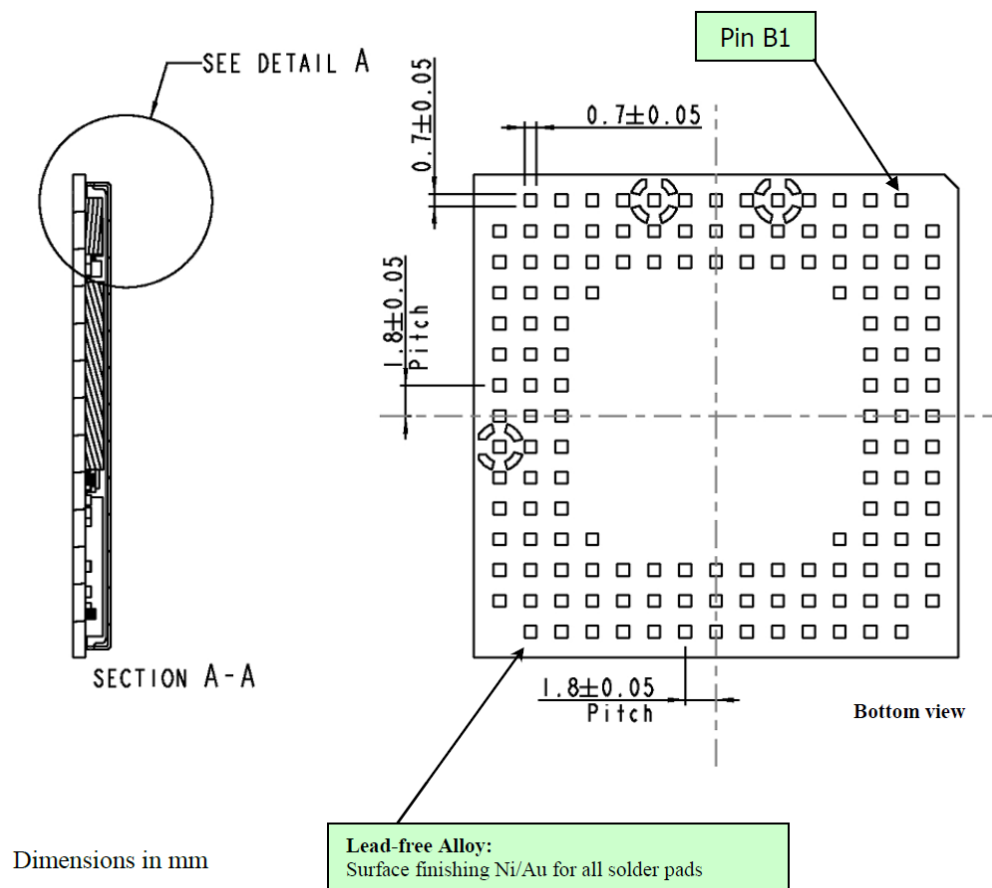
12.1. General

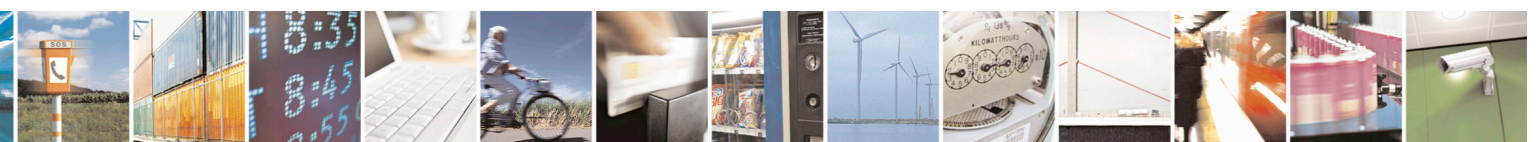
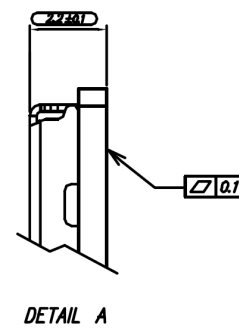
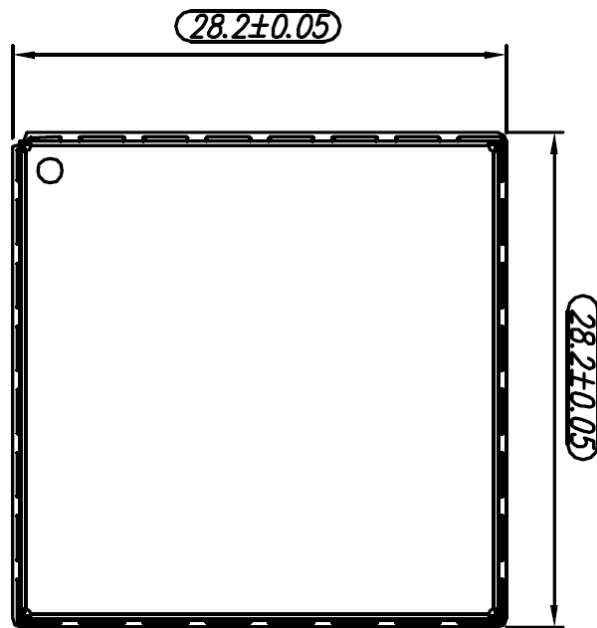
The UE910-EU V2 AUTO has been designed in order to be compliant with a standard lead-free SMT process.

12.2. Module Finishing & Dimensions

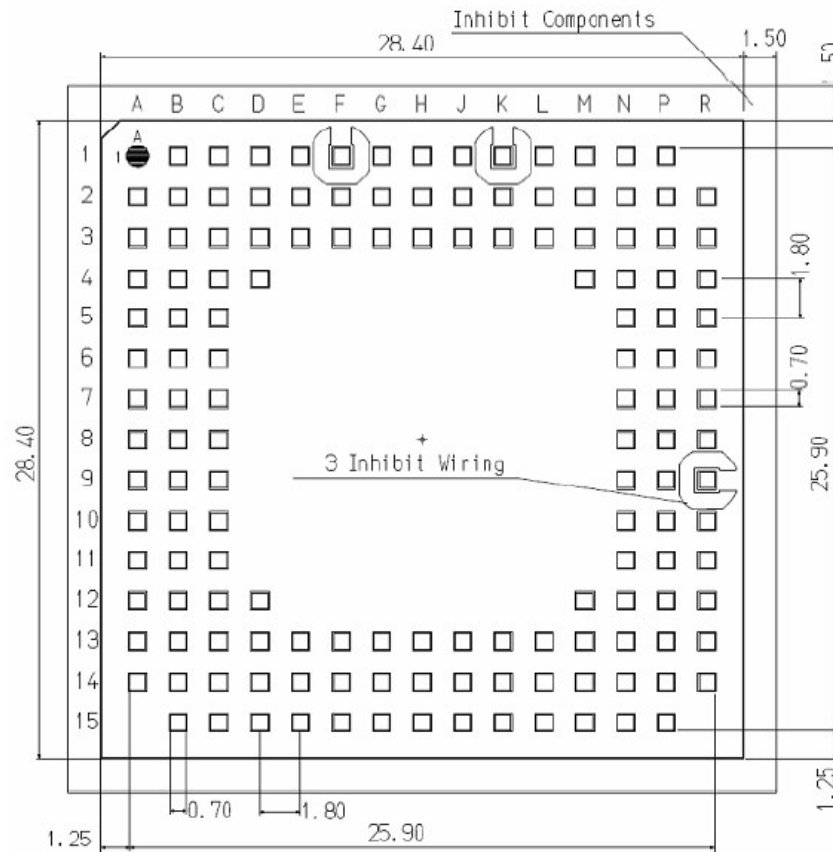
The UE910-EU V2 AUTO overall dimensions are:

- Length : 28.2 mm
- Width : 28.2 mm
- Thickness : 2.2 mm
- Weight : 4.1 g





12.3. Recommended foot print for the application



144 pins

< Top View >

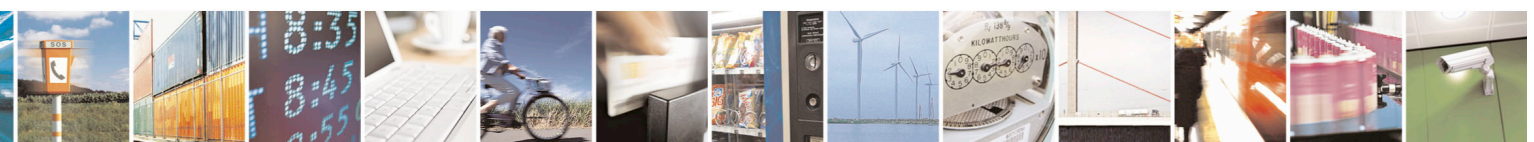
In order to easily rework the UE910-EU V2 AUTO it is suggested to consider having a 1.5 mm placement inhibit area around the module on the application.

It is also suggested, as a common rule for an SMT component, to avoid having a mechanical part of the application in direct contact with the module.



NOTE:

In the customer application, the region under WIRING INHIBIT (see figure) must be clear from signal or ground paths.

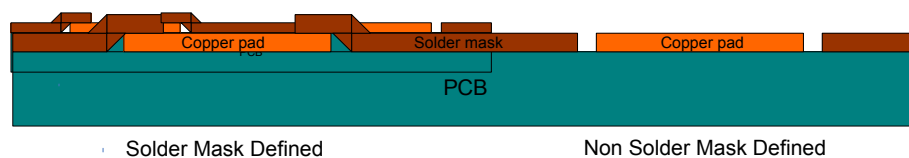


12.4. Stencil

Stencil's apertures layout can be the same as the recommended footprint (1:1). A suggested thickness of stencil foil $\geq 120 \mu\text{m}$.

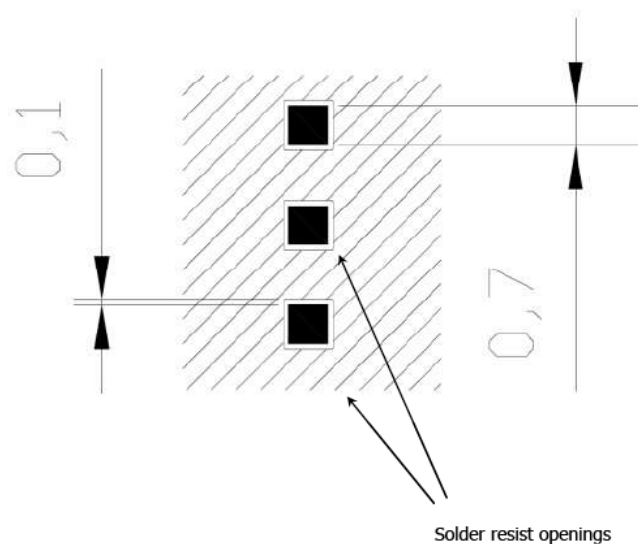
12.5. PCB Pad Design

Non solder mask defined (NSMD) type is recommended for the solder pads on the PCB.

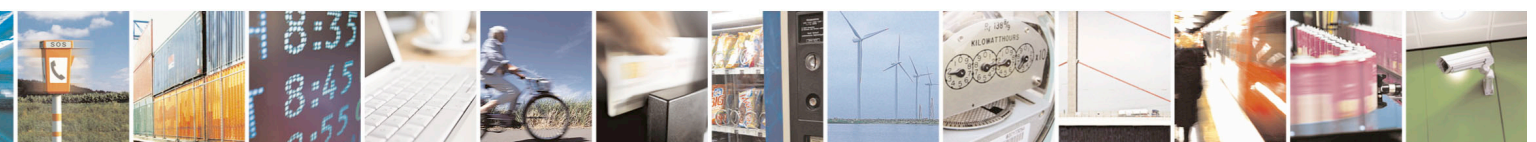


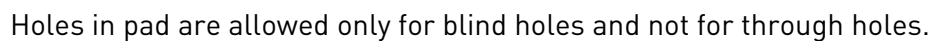
12.6. Recommendations for PCB Pad Dimensions (mm)

The recommendation for the PCB pads dimensions are described in the following image(dimensions in mm)



It is not recommended to place via or micro-via not covered by solder resist in an area of 0.3 mm around the pads unless it carries the same signal as the pad itself (see following figure).





Finish	Layer thickness (um)	Properties
Electro-less Ni / Immersion Au	3 ~ 7 / 0.05 ~ 0.15	good solder ability protection, high shear force values

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Profile Feature	Pb-Free Assembly
Peak Temperature (T_P)	245 $\pm 0/-5^\circ\text{C}$
Time within 5°C of actual Peak Temperature (t_P)	10 ~30 seconds
Ramp-down Rate	6 $^\circ\text{C}/\text{sec}$ max
Time 25°C to Peak Temperature	8 minutes max



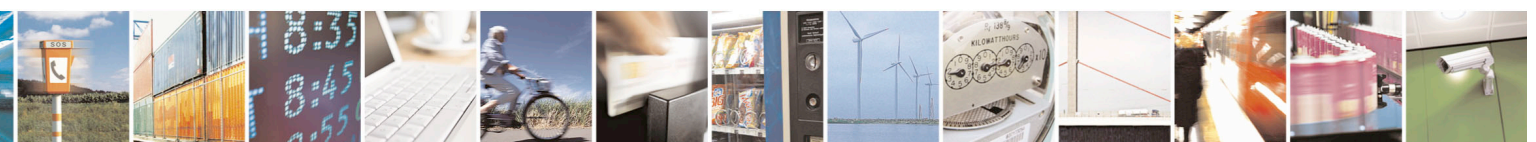
NOTE:

All temperatures refer to topside of the package, measured on the package body surface.



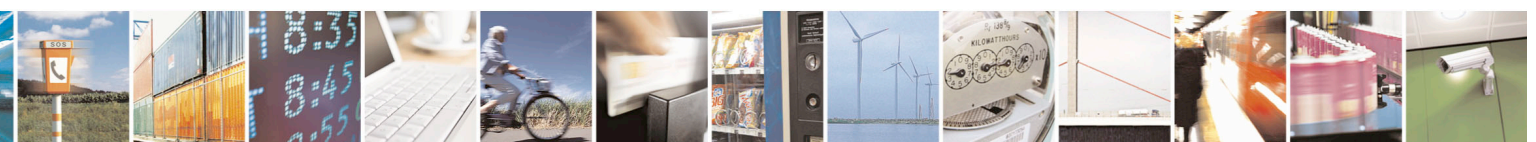
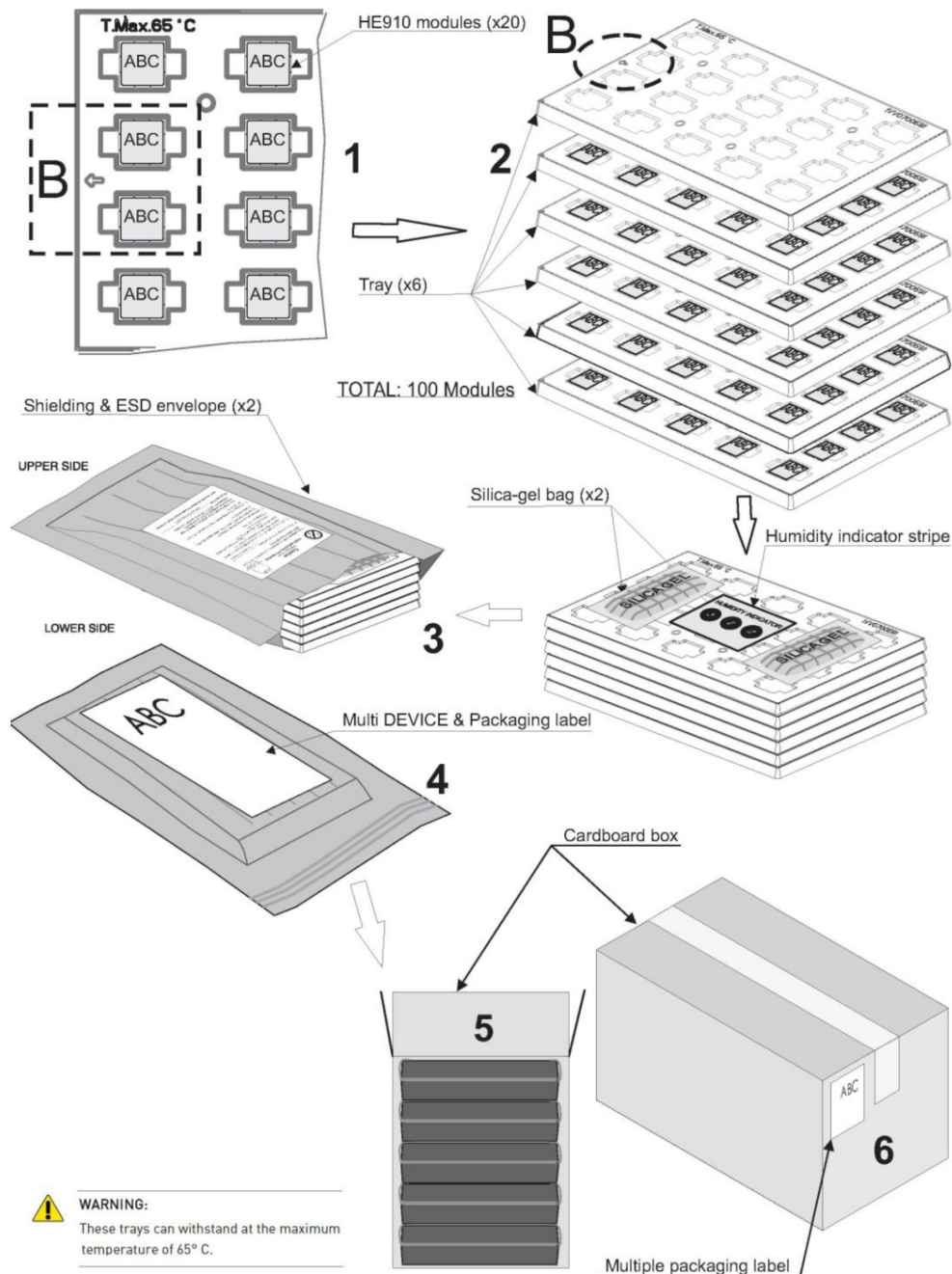
WARNING:

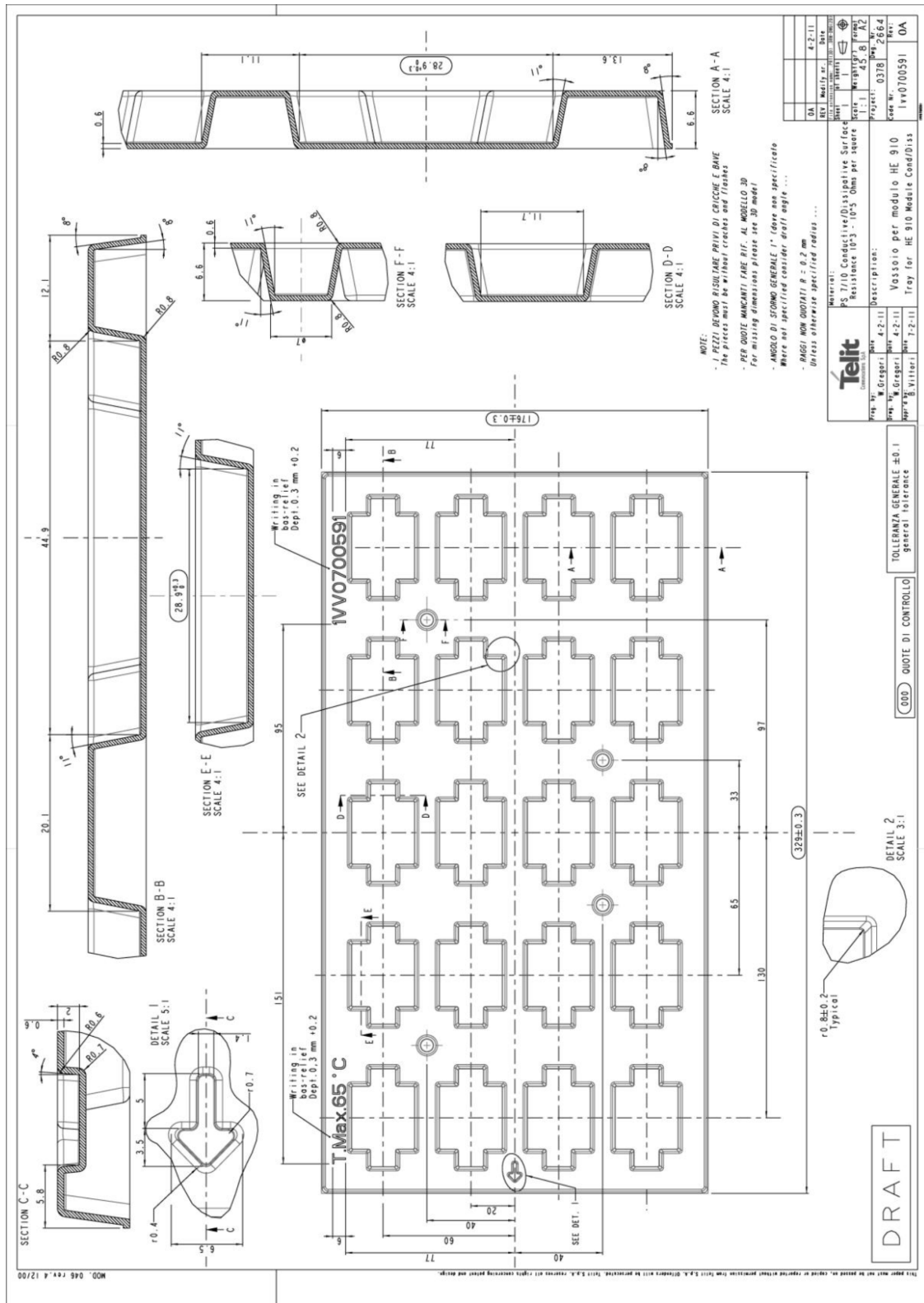
The UE910-EU V2 AUTO module withstands one reflow process only.



13. Packing System

The UE910-EU V2 AUTO modules are packaged on trays of 20 pieces each. These trays can be used in SMT processes for pick & place handling.



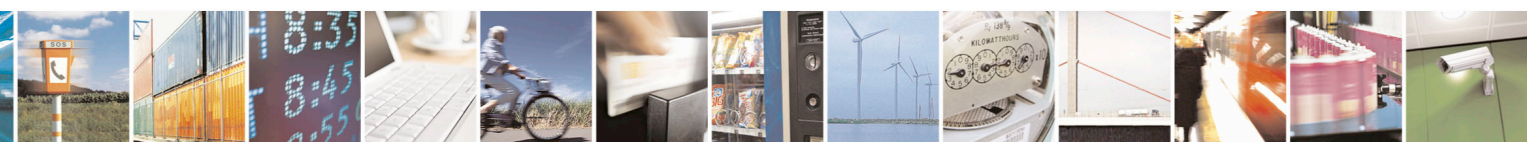


13.1. Moisture Sensibility

The UE910-EU V2 AUTO is a Moisture Sensitive Device level 3, in accordance with standard IPC/JEDEC J-STD-020, take care all the relative requirements for using this kind of components.

Moreover, the customer has to take care of the following conditions:

- a) Calculated shelf life in sealed bag: 12 months at < 40°C and 90% relative humidity (RH).
- b) Environmental condition during the production: 30°C / 60% RH according to IPC/JEDEC J-STD-033A paragraph 5.
- c) The maximum time between the opening of the sealed bag and the reflow process must be 168hours if condition b) "IPC/JEDEC J-STD-033A paragraph 5.2" is respected
- d) Baking is required if conditions b) or c) are not respected
- e) Baking is required if the humidity indicator inside the bag indicates 10% RH or more



14. Application Design Guide

14.1. Download and Debug Port

One of the following options should be chosen in the design of host system in order to download or upgrade the Telit's software and debug UE910-EU V2 AUTO when it is already mounted on a host system.

CASE I:

Users who use both of UART and USB interfaces to communicate with UE910-EU V2 AUTO

- Must implement a download method in a host system for upgrading UE910-EU V2 AUTO when it's mounted.

CASE II:

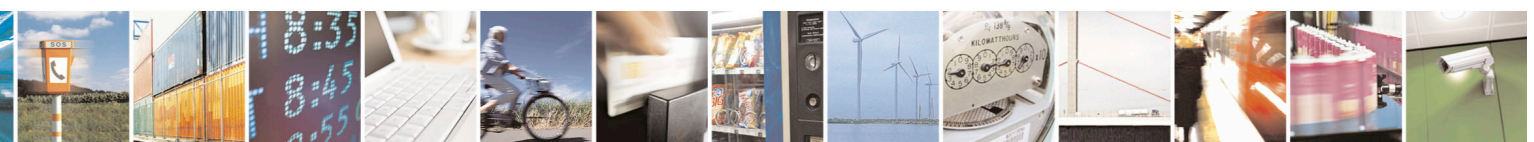
Users who use USB interface only to communicate with UE910-EU V2 AUTO

- Must arrange UART port in a host system for debugging or upgrading UE910-EU V2 AUTO when it's mounted.

CASE III:

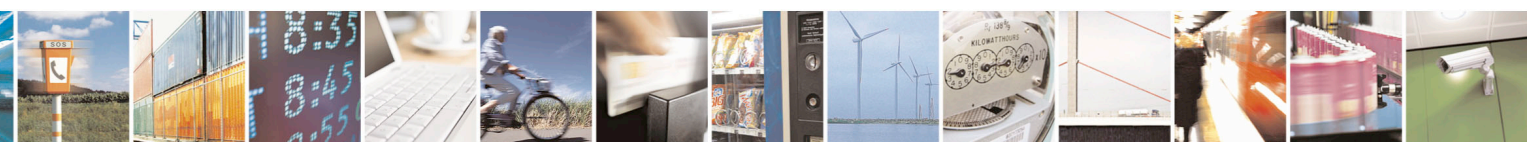
Users who use UART interface only to communicate with UE910-EU V2 AUTO

- Must arrange USB port in a host system for debugging or upgrading UE910-EU V2 AUTO when it's mounted.



15. Conformity Assessment Issues(Problèmes d'évaluation de conformité)

It will be updated.



16. Safety Recommendations

READ CAREFULLY

Be sure the use of this product is allowed in the country and in the environment required. The use of this product may be dangerous and has to be avoided in the following areas:

- Where it can interfere with other electronic devices in environments such as hospitals, airports, aircrafts, etc.
- Where there is risk of explosion such as gasoline stations, oil refineries, etc. It is the responsibility of the user to enforce the country's regulations and the specific environmental regulation.

Do not disassemble the product; any evidence of tampering will compromise the warranty validity. Follow the instructions of the hardware user guides for a correct wiring of the product. The product has to be supplied with a stabilized voltage source and the wiring has to conform to the security and fire prevention regulations. The product has to be handled with care, avoiding any contact with the pads because electrostatic discharges may damage the product itself.

The system integrator is responsible for the functioning of the final product; therefore, care has to be taken with the external components of the module as well as of any project or installation issue because of the risk of disturbing the GSM/WCDMA network or external devices or having impact on security. Should there be any doubt, please refer to the technical documentation and the regulations in force. Every module has to be equipped with a proper antenna with specific characteristics. The antenna has to be installed with care in order to avoid any interference with other electronic devices and has to guarantee a minimum distance from the body (20 cm). In case this requirement cannot be satisfied, the system integrator has to assess the final product against SAR regulations.



17. Document History

Revision	Date	Changes
0	2013-08-22	Preliminary release
1	2013-10-16	Changed Audio block diagram

